

World's Lowest Power 9-Axis MEMS MotionTracking™ Device

GENERAL DESCRIPTION

The ICM-20948 is the world's lowest power 9-axis MotionTracking device that is ideally suited for Smartphones, Tablets, Wearable Sensors, and IoT applications.

- 3-axis gyroscope, 3-axis accelerometer, 3-axis compass, and a Digital Motion Processor™ (DMP™) in a 3 mm x 3 mm x 1 mm (24-pin QFN) package
- DMP offloads computation of motion processing algorithms from the host processor, improving system power performance
- Software drivers are fully compliant with Google's latest Android release
- EIS FSYNC support

ICM-20948 supports an auxiliary I²C interface to external sensors, on-chip 16-bit ADCs, programmable digital filters, an embedded temperature sensor, and programmable interrupts. The device features an operating voltage range down to 1.71V. Communication ports include I²C and high speed SPI at 7 MHz.

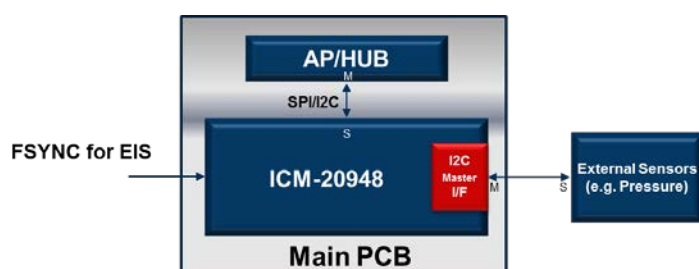
Note: ICM-20948 VDDIO range is 1.71V to 1.95V, different than the MPU-9250 9-axis device.

ORDERING INFORMATION

PART	TEMP RANGE	PACKAGE
ICM-20948†	-40°C to +85°C	24-Pin QFN

†Denotes RoHS and Green-Compliant Package

BLOCK DIAGRAM



APPLICATIONS

- Smartphones and Tablets
- Wearable Sensors
- IoT Applications

FEATURES

- Lowest Power 9-Axis Device at 2.5 mW
- 3-Axis Gyroscope with Programmable FSR of ± 250 dps, ± 500 dps, ± 1000 dps, and ± 2000 dps
- 3-Axis Accelerometer with Programmable FSR of $\pm 2g$, $\pm 4g$, $\pm 8g$, and $\pm 16g$
- 3-Axis Compass with a wide range to $\pm 4900 \mu T$
- Onboard Digital Motion Processor (DMP)
- Android support
- Auxiliary I²C interface for external sensors
- On-Chip 16-bit ADCs and Programmable Filters
- 7 MHz SPI or 400 kHz Fast Mode I²C
- Digital-output temperature sensor
- VDD operating range of 1.71V to 3.6V
- MEMS structure hermetically sealed and bonded at wafer level
- RoHS and Green compliant

TYPICAL OPERATING CIRCUIT

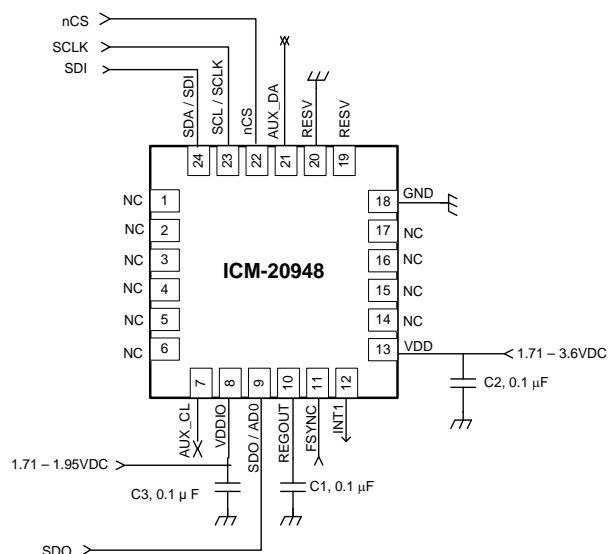


TABLE OF CONTENTS

GENERAL DESCRIPTION	1
ORDERING INFORMATION	1
BLOCK DIAGRAM	1
APPLICATIONS	1
FEATURES	1
TYPICAL OPERATING CIRCUIT	1
1 GENERAL DESCRIPTION	9
1.1 PURPOSE AND SCOPE	9
1.2 PRODUCT OVERVIEW	9
1.3 APPLICATIONS	9
2 FEATURES	10
2.1 GYROSCOPE FEATURES	10
2.2 ACCELEROMETER FEATURES	10
2.3 MAGNETOMETER FEATURES	10
2.4 DMP FEATURES	10
2.5 ADDITIONAL FEATURES	10
3 ELECTRICAL CHARACTERISTICS	11
3.1 GYROSCOPE SPECIFICATIONS	11
3.2 ACCELEROMETER SPECIFICATIONS	12
3.3 MAGNETOMETER SPECIFICATIONS	13
3.4 ELECTRICAL SPECIFICATIONS	13
<i>D.C. Electrical Characteristics</i>	13
<i>A.C. Electrical Characteristics</i>	14
<i>Other Electrical Specifications</i>	15
3.5 I ² C TIMING CHARACTERIZATION	16
3.6 SPI TIMING CHARACTERIZATION	17
3.7 ABSOLUTE MAXIMUM RATINGS	18
4 APPLICATIONS INFORMATION	19
4.1 PIN OUT DIAGRAM AND SIGNAL DESCRIPTION	19
4.2 TYPICAL OPERATING CIRCUIT	20
4.3 BILL OF MATERIALS FOR EXTERNAL COMPONENTS	20
4.4 EXPOSED DIE PAD PRECAUTIONS	20
4.5 BLOCK DIAGRAM	21
4.6 OVERVIEW	21
4.7 THREE-AXIS MEMS GYROSCOPE WITH 16-BIT ADCs AND SIGNAL CONDITIONING	22
4.8 THREE-AXIS MEMS ACCELEROMETER WITH 16-BIT ADCs AND SIGNAL CONDITIONING	22
4.9 THREE-AXIS MEMS MAGNETOMETER WITH 16-BIT ADCs AND SIGNAL CONDITIONING	22
4.10 DIGITAL MOTION PROCESSOR	22
4.11 PRIMARY I ² C AND SPI SERIAL COMMUNICATIONS INTERFACES	22
<i>ICM-20948 Solution Using I²C Interface</i>	22
<i>ICM-20948 Solution Using SPI Interface</i>	23
4.12 AUXILIARY I ² C SERIAL INTERFACE	24
4.13 SELF-TEST	24
4.14 CLOCKING	25
4.15 SENSOR DATA REGISTERS	25

4.16	FIFO.....	25
4.17	FSYNC.....	25
4.18	INTERRUPTS.....	25
4.19	DIGITAL-OUTPUT TEMPERATURE SENSOR.....	26
4.20	BIAS AND LDOS	26
4.21	CHARGE PUMP.....	26
4.22	POWER MODES.....	26
5	PROGRAMMABLE INTERRUPTS.....	27
6	DIGITAL INTERFACE.....	28
6.1	I ² C AND SPI SERIAL INTERFACES	28
6.2	I ² C INTERFACE	28
6.3	I ² C COMMUNICATIONS PROTOCOL	28
6.4	I ² C TERMS	30
6.5	SPI INTERFACE.....	31
7	REGISTER MAP FOR GYROSCOPE AND ACCELEROMETER	32
7.1	USER BANK 0 REGISTER MAP	32
7.2	USER BANK 1 REGISTER MAP	33
7.3	USER BANK 2 REGISTER MAP	34
7.4	USER BANK 3 REGISTER MAP	34
8	USER BANK 0 REGISTER DESCRIPTIONS.....	36
8.1	WHO_AM_I.....	36
8.2	USER_CTRL.....	36
8.3	LP_CONFIG.....	37
8.4	PWR_MGMT_1	37
8.5	PWR_MGMT_2	38
8.6	INT_PIN_CFG	38
8.7	INT_ENABLE	39
8.8	INT_ENABLE_1	39
8.9	INT_ENABLE_2	39
8.10	INT_ENABLE_3.....	40
8.11	I2C_MST_STATUS	40
8.12	INT_STATUS	40
8.13	INT_STATUS_1	41
8.14	INT_STATUS_2	41
8.15	INT_STATUS_3	41
8.16	DELAY_TIMEH	41
8.17	DELAY_TIMEL.....	42
8.18	ACCEL_XOUT_H	42
8.19	ACCEL_XOUT_L	42
8.20	ACCEL_YOUT_H	42
8.21	ACCEL_YOUT_L	43
8.22	ACCEL_ZOUT_H	43
8.23	ACCEL_ZOUT_L	43
8.24	GYRO_XOUT_H	43
8.25	GYRO_XOUT_L.....	44
8.26	GYRO_YOUT_H	44
8.27	GYRO_YOUT_L.....	44
8.28	GYRO_ZOUT_H	44

8.29	GYRO_ZOUT_L	45
8.30	TEMP_OUT_H	45
8.31	TEMP_OUT_L	45
8.32	EXT_SLV_SENS_DATA_00	45
8.33	EXT_SLV_SENS_DATA_01	46
8.34	EXT_SLV_SENS_DATA_02	46
8.35	EXT_SLV_SENS_DATA_03	46
8.36	EXT_SLV_SENS_DATA_04	46
8.37	EXT_SLV_SENS_DATA_05	47
8.38	EXT_SLV_SENS_DATA_06	47
8.39	EXT_SLV_SENS_DATA_07	47
8.40	EXT_SLV_SENS_DATA_08	47
8.41	EXT_SLV_SENS_DATA_09	48
8.42	EXT_SLV_SENS_DATA_10	48
8.43	EXT_SLV_SENS_DATA_11	48
8.44	EXT_SLV_SENS_DATA_12	48
8.45	EXT_SLV_SENS_DATA_13	49
8.46	EXT_SLV_SENS_DATA_14	49
8.47	EXT_SLV_SENS_DATA_15	49
8.48	EXT_SLV_SENS_DATA_16	49
8.49	EXT_SLV_SENS_DATA_17	50
8.50	EXT_SLV_SENS_DATA_18	50
8.51	EXT_SLV_SENS_DATA_19	50
8.52	EXT_SLV_SENS_DATA_20	50
8.53	EXT_SLV_SENS_DATA_21	51
8.54	EXT_SLV_SENS_DATA_22	51
8.55	EXT_SLV_SENS_DATA_23	51
8.56	FIFO_EN_1	52
8.57	FIFO_EN_2	52
8.58	FIFO_RST	53
8.59	FIFO_MODE	53
8.60	FIFO_COUNTH	53
8.61	FIFO_COUNTL	53
8.62	FIFO_R_W	54
8.63	DATA_RDY_STATUS	54
8.64	FIFO_CFG	54
8.65	REG_BANK_SEL	54
9	USR BANK 1 REGISTER DESCRIPTIONS	55
9.1	SELF_TEST_X_GYRO	55
9.2	SELF_TEST_Y_GYRO	55
9.3	SELF_TEST_Z_GYRO	55
9.4	SELF_TEST_X_ACCEL	55
9.5	SELF_TEST_Y_ACCEL	56
9.6	SELF_TEST_Z_ACCEL	56
9.7	XA_OFFSETS_H	56
9.8	XA_OFFSETS_L	56
9.9	YA_OFFSETS_H	56
9.10	YA_OFFSETS_L	57
9.11	ZA_OFFSETS_H	57
9.12	ZA_OFFSETS_L	57

9.13	TIMEBASE_CORRECTION_PLL	57
9.14	REG_BANK_SEL	58
10	USR BANK 2 REGISTER MAP	59
10.1	GYRO_SMPLRT_DIV	59
10.2	GYRO_CONFIG_1	59
10.3	GYRO_CONFIG_2	60
10.4	XG_OFFS_USRH	61
10.5	XG_OFFS_USRL	62
10.6	YG_OFFS_USRH	62
10.7	YG_OFFS_USRL	62
10.8	ZG_OFFS_USRH	62
10.9	ZG_OFFS_USRL	62
10.10	ODR_ALIGN_EN	63
10.11	ACCEL_SMPLRT_DIV_1	63
10.12	ACCEL_SMPLRT_DIV_2	63
10.13	ACCEL_INTEL_CTRL	63
10.14	ACCEL_WOM_THR	64
10.15	ACCEL_CONFIG	64
10.16	ACCEL_CONFIG_2	65
10.17	FSYNC_CONFIG	66
10.18	TEMP_CONFIG	67
10.19	MOD_CTRL_USR	67
10.20	REG_BANK_SEL	67
11	USR BANK 3 REGISTER MAP	68
11.1	I2C_MST_ODR_CONFIG	68
11.2	I2C_MST_CTRL	68
11.3	I2C_MST_DELAY_CTRL	69
11.4	I2C_SLV0_ADDR	69
11.5	I2C_SLV0_REG	69
11.6	I2C_SLV0_CTRL	70
11.7	I2C_SLV0_DO	70
11.8	I2C_SLV1_ADDR	70
11.9	I2C_SLV1_REG	71
11.10	I2C_SLV1_CTRL	71
11.11	I2C_SLV1_DO	72
11.12	I2C_SLV2_ADDR	72
11.13	I2C_SLV2_REG	72
11.14	I2C_SLV2_CTRL	73
11.15	I2C_SLV2_DO	73
11.16	I2C_SLV3_ADDR	73
11.17	I2C_SLV3_REG	74
11.18	I2C_SLV3_CTRL	74
11.19	I2C_SLV3_DO	74
11.20	I2C_SLV4_ADDR	75
11.21	I2C_SLV4_REG	75
11.22	I2C_SLV4_CTRL	75
11.23	I2C_SLV4_DO	75
11.24	I2C_SLV4_DI	76
11.25	REG_BANK_SEL	76

12	REGISTER MAP FOR MAGNETOMETER	77
12.1	REGISTER MAP DESCRIPTION	77
13	DETAILED DESCRIPTIONS FOR MAGNETOMETER REGISTERS	78
13.1	WIA: DEVICE ID	78
13.2	ST1: STATUS 1	78
13.3	HXL TO HZH: MEASUREMENT DATA	78
13.4	ST2: STATUS 2	79
13.5	CNTL2: CONTROL 2	79
13.6	CNTL3: CONTROL 3	80
13.7	TS1, TS2: TEST 1, 2	80
14	USE NOTES	81
14.1	GYROSCOPE MODE TRANSITION	81
14.2	POWER MANAGEMENT 1 REGISTER SETTING	81
14.3	DMP MEMORY ACCESS	81
14.4	TIME BASE CORRECTION	81
14.5	I ² C MASTER CLOCK FREQUENCY	81
14.6	CLOCKING	82
14.7	LP_EN BIT-FIELD USAGE	82
14.8	REGISTER ACCESS USING SPI INTERFACE	82
15	ORIENTATION OF AXES	83
16	PACKAGE DIMENSIONS	84
17	PART NUMBER PART MARKINGS.....	86
18	REFERENCES	87
19	DOCUMENT INFORMATION	88
19.1	REVISION HISTORY	88
	COMPLIANCE DECLARATION DISCLAIMER	89

LIST OF FIGURES

Figure 1. I ² C Bus Timing Diagram.....	16
Figure 2. SPI Bus Timing Diagram	17
Figure 3. Pin out Diagram for ICM-20948 3 mm x 3 mm x 1 mm QFN	19
Figure 4. ICM-20948 Application Schematic (a) I ² C operation (b) SPI operation	20
Figure 5. ICM-20948 Block Diagram	21
Figure 6. ICM-20948 Solution Using I ² C Interface	23
Figure 7. ICM-20948 Solution Using SPI Interface.....	24
Figure 8. START and STOP Conditions	28
Figure 9. Acknowledge on the I ² C Bus.....	29
Figure 10. Complete I ² C Data Transfer	29
Figure 11. Typical SPI Master / Slave Configuration.....	31
Figure 12. Orientation of Axes of Sensitivity and Polarity of Rotation.....	83
Figure 13. Orientation of Axes of Sensitivity for Magnetometer	83
Figure 14. Package Dimensions	84
Figure 15. Part Number Part Markings.....	86

LIST OF TABLES

Table 1. Gyroscope Specifications	11
Table 2. Accelerometer Specifications	12
Table 3. Magnetometer Specifications.....	13
Table 4. D.C. Electrical Characteristics.....	13
Table 5. A.C. Electrical Characteristics.....	15
Table 6. Other Electrical Specifications	15
Table 7. I ² C Timing Characteristics	16
Table 8. SPI Timing Characteristics (7 MHz)	17
Table 9. Absolute Maximum Ratings.....	18
Table 10. Signal Descriptions.....	19
Table 11. Bill of Materials	20
Table 12. Power Modes for ICM-20948.....	26
Table 13. Interrupt Sources	27
Table 14. Serial Interface.....	28
Table 15. I ² C Terms	30
Table 16. Gyroscope Configuration 1	60
Table 17. Gyroscope Configuration 2	61
Table 18. Accelerator Configuration.....	64
Table 19. Accelerator Configuration 2.....	66
Table 20. Register Table for Magnetometer	77
Table 21. Register Map for Magnetometer.....	77
Table 22. Magnetometer Measurement Data Format.....	79
Table 23. I ² C Master Clock Frequency	82
Table 24. Package Dimensions	85
Table 26. Part Number Part Markings	86

1 GENERAL DESCRIPTION

1.1 PURPOSE AND SCOPE

This document is a preliminary data sheet, providing a description, specifications, and design related information on the ICM-20948 MotionTracking device.

For references to register map and descriptions of individual registers, please refer to the ICM-20948 Register Map and Register Descriptions document.

1.2 PRODUCT OVERVIEW

The ICM-20948 is a multi-chip module (MCM) consisting of two dies integrated into a single QFN package. One die houses a 3-axis gyroscope, a 3-axis accelerometer, and a Digital Motion Processor™ (DMP). The other die houses the AK09916 3-axis magnetometer from Asahi Kasei Microdevices Corporation. The ICM-20948 is a 9-axis MotionTracking device all in a small 3x3x1mm QFN package. The device supports the following features:

- FIFO of size 512 bytes (FIFO size will vary depending on DMP feature-set)
- Runtime Calibration
- Enhanced FSYNC functionality to improve timing for applications like EIS

ICM-20948 devices, with their 9-axis integration, on-chip DMP, and run-time calibration firmware, enable manufacturers to eliminate the costly and complex selection, qualification, and system level integration of discrete devices, guaranteeing optimal motion performance for consumers.

The gyroscope has a programmable full-scale range of ± 250 dps, ± 500 dps, ± 1000 dps, and ± 2000 dps. The accelerometer has a user-programmable accelerometer full-scale range of $\pm 2g$, $\pm 4g$, $\pm 8g$, and $\pm 16g$. Factory-calibrated initial sensitivity of both sensors reduces production-line calibration requirements.

Other key features include on-chip 16-bit ADCs, programmable digital filters, an embedded temperature sensor, and programmable interrupts. The device features I²C and SPI serial interfaces, a VDD operating range of 1.71V to 3.6V, and a separate digital IO supply, VDDIO from 1.71V to 1.95V.

Communication with all registers of the device is performed using I²C at up to 100 kHz (standard-mode) or up to 400 kHz (fast-mode), or SPI at up to 7 MHz.

By leveraging its patented and volume-proven CMOS-MEMS fabrication platform, which integrates MEMS wafers with companion CMOS electronics through wafer-level bonding, InvenSense has driven the package size down to a footprint and thickness of 3 mm x 3 mm x 1 mm (24-pin QFN), to provide a very small yet high-performance, low-cost package. The device provides high robustness by supporting 20,000g shock reliability.

1.3 APPLICATIONS

- Smartphones and Tablets
- Wearable Sensors
- IoT Applications
- Drones

2 FEATURES

2.1 GYROSCOPE FEATURES

The triple-axis MEMS gyroscope in the ICM-20948 includes the following features:

- Digital-output X-, Y-, and Z-axis angular rate sensors (gyroscopes) with a user-programmable full-scale range of ± 250 dps, ± 500 dps, ± 1000 dps, and ± 2000 dps, and integrated 16-bit ADCs
- User-selectable ODR; User-selectable low pass filters
- Self-test

2.2 ACCELEROMETER FEATURES

The triple-axis MEMS accelerometer in ICM-20948 includes the following features:

- Digital-output X-, Y-, and Z-axis accelerometer with a programmable full scale range of $\pm 2g$, $\pm 4g$, $\pm 8g$, and $\pm 16g$, and integrated 16-bit ADCs
- User-selectable ODR; User-selectable low pass filters
- Wake-on-motion interrupt for low power operation of applications processor
- Self-test

2.3 MAGNETOMETER FEATURES

The triple-axis MEMS magnetometer in ICM-20948 includes a wide range of features:

- 3-axis silicon monolithic Hall-effect magnetic sensor with magnetic concentrator
- Wide dynamic measurement range and high resolution with lower current consumption.
- Output data resolution of 16-bits
- Full scale measurement range is $\pm 4900 \mu T$
- Self-test function with internal magnetic source to confirm magnetic sensor operation on end products

2.4 DMP FEATURES

The DMP in ICM-20948 includes the following capabilities:

- Offloads computation of motion processing algorithms from the host processor. The DMP can be used to minimize power, simplify timing, simplify the software architecture, and save valuable MIPS on the host processor for use in applications.
- The DMP enables ultra-low power run-time and background calibration of the accelerometer, gyroscope, and compass, maintaining optimal performance of the sensor data for both physical and virtual sensors generated through sensor fusion. This enables the best user experience for all sensor enabled applications for the lifetime of the device.
- DMP features simplify the software architecture resulting in quicker time to market.
- DMP features are OS, Platform, and Architecture independent, supporting virtually any AP, MCU, or other embedded architecture.

2.5 ADDITIONAL FEATURES

The ICM-20948 includes the following additional features:

- I²C at up to 100 kHz (standard-mode) or up to 400 kHz (fast-mode) or SPI at up to 7 MHz for communication with registers
- Auxiliary master I²C bus for reading data from external sensors (e.g. magnetometer)
- Digital-output temperature sensor
- 20,000g shock tolerant
- MEMS structure hermetically sealed and bonded at wafer level
- RoHS and Green compliant

3 ELECTRICAL CHARACTERISTICS

3.1 GYROSCOPE SPECIFICATIONS

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

NOTE: All specifications apply to Low-Power Mode and Low-Noise Mode, unless noted otherwise

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
GYROSCOPE SENSITIVITY						
Full-Scale Range	GYRO_FS_SEL=0		±250		dps	1
	GYRO_FS_SEL=1		±500		dps	1
	GYRO_FS_SEL=2		±1000		dps	1
	GYRO_FS_SEL=3		±2000		dps	1
Gyroscope ADC Word Length			16		bits	1
Sensitivity Scale Factor	GYRO_FS_SEL=0		131		LSB/(dps)	1
	GYRO_FS_SEL=1		65.5		LSB/(dps)	1
	GYRO_FS_SEL=2		32.8		LSB/(dps)	1
	GYRO_FS_SEL=3		16.4		LSB/(dps)	1
Sensitivity Scale Factor Tolerance	25°C		±1.5		%	2
Sensitivity Scale Factor Variation Over Temperature	-40°C to +85°C		±3		%	2
Nonlinearity	Best fit straight line; 25°C		±0.1		%	2, 3
Cross-Axis Sensitivity			±2		%	2, 3
ZERO-RATE OUTPUT (ZRO)						
Initial ZRO Tolerance	25°C (Component-level)		±5		dps	2
ZRO Variation Over Temperature	-40°C to +85°C		±0.05		dps/°C	2
GYROSCOPE NOISE PERFORMANCE (GYRO_FS_SEL=0)						
Noise Spectral Density	Based on Noise Bandwidth = 10 Hz		0.015		dps/√Hz	2
GYROSCOPE MECHANICAL FREQUENCIES		25	27	29	kHz	2
LOW PASS FILTER RESPONSE	Programmable Range	5.7		197	Hz	1, 3
GYROSCOPE START-UP TIME	From Full-Chip Sleep mode		35		ms	2, 3
OUTPUT DATA RATE	Low-Power Mode	4.4		562.5	Hz	1
	Low-Noise Mode GYRO_FCHOICE=1; GYRO_DLPFCFG=x	4.4		1.125k	Hz	
	Low-Noise Mode GYRO_FCHOICE=0; GYRO_DLPFCFG=x			9k	Hz	

Table 1. Gyroscope Specifications

NOTES:

1. Guaranteed by design.
2. Derived from validation or characterization of parts, not guaranteed in production.
3. Low-noise mode specification.

3.2 ACCELEROMETER SPECIFICATIONS

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

NOTES: All specifications apply to Low-Power Mode and Low-Noise Mode, unless noted otherwise

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
ACCELEROMETER SENSITIVITY						
Full-Scale Range	ACCEL_FS=0		±2		G	1
	ACCEL_FS=1		±4		G	1
	ACCEL_FS=2		±8		G	1
	ACCEL_FS=3		±16		G	1
ADC Word Length	Output in two's complement format		16		Bits	1
Sensitivity Scale Factor	ACCEL_FS=0		16,384		LSB/g	1
	ACCEL_FS=1		8,192		LSB/g	1
	ACCEL_FS=2		4,096		LSB/g	1
	ACCEL_FS=3		2,048		LSB/g	1
Initial Tolerance	Component-level		±0.5		%	2
Sensitivity Change vs. Temperature	-40°C to +85°C ACCEL_FS=0		±0.026		%/°C	2
Nonlinearity	Best Fit Straight Line		±0.5		%	2, 3
Cross-Axis Sensitivity			±2		%	2, 3
ZERO-G OUTPUT						
Initial Tolerance	Component-level, all axes		±25		mg	2
Initial Tolerance	Board-level, all axes		±50		mg	2
Zero-G Level Change vs. Temperature	0°C to +85°C		±0.80		mg/°C	2
ACCELEROMETER NOISE PERFORMANCE						
Noise Spectral Density	Based on Noise Bandwidth = 10 Hz		230		µg/√Hz	2
LOW PASS FILTER RESPONSE	Programmable Range	5.7		246	Hz	1, 3
ACCELEROMETER STARTUP TIME	From Sleep mode		20		ms	2, 3
	From Cold Start, 1 ms V _{DD} ramp		30		ms	2, 3
OUTPUT DATA RATE	Low-Power Mode	0.27		562.5	Hz	1
	Low-Noise Mode ACCEL_FCHOICE=1; ACCEL_DLPFCFG=x	4.5		1.125k	Hz	
	Low-Noise Mode ACCEL_FCHOICE=0; ACCEL_DLPFCFG=x			4.5k	Hz	

Table 2. Accelerometer Specifications

NOTES:

1. Guaranteed by design.
2. Derived from validation or characterization of parts, not guaranteed in production.
3. Low-noise mode specification.

3.3 MAGNETOMETER SPECIFICATIONS

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
MAGNETOMETER SENSITIVITY						
Full-Scale Range			±4900		μT	1
Output Resolution			16		bits	1
Sensitivity Scale Factor			0.15		μT / LSB	1
ZERO-FIELD OUTPUT						
Initial Calibration Tolerance		-2000		+2000	LSB	2
OTHER						
Output Data Rate				100	Hz	1

Table 3. Magnetometer Specifications

NOTES:

1. Guaranteed by design.
2. Derived from validation or characterization of parts, not guaranteed in production.

3.4 ELECTRICAL SPECIFICATIONS

D.C. Electrical Characteristics

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
SUPPLY VOLTAGES						
VDD		1.71	1.8	3.6	V	1
VDDIO		1.71	1.8	1.95	V	1
SUPPLY CURRENTS						
9-Axis (DMP disabled)	Low-Noise Mode; Compass in Continuous Mode		3.11		mA	2
Gyroscope Only (DMP, Barometer & Accelerometer disabled)	Low-Power Mode, 102.3 Hz update rate, 1x averaging filter		1.23		mA	2
Accelerometer Only (DMP, Barometer & Gyroscope disabled)	Low-Power Mode, 102.3 Hz update rate, 1x averaging filter		68.9		μA	2
Magnetometer Only (DMP, Accelerometer & Gyroscope disabled)	8 Hz update rate		90		μA	2
Full-Chip Sleep Mode			8		μA	2
TEMPERATURE RANGE						
Specified Temperature Range	Performance parameters are not applicable beyond Specified Temperature Range	-40		+85	°C	1

Table 4. D.C. Electrical Characteristics

NOTES:

1. Guaranteed by design.
2. Derived from validation or characterization of parts, not guaranteed in production.

A.C. Electrical Characteristics

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
SUPPLIES						
Supply Ramp Time (T _{RAMP})	Monotonic ramp. Ramp rate is 10% to 90% of the final value.	0.01	20	100	ms	1
TEMPERATURE SENSOR						
Operating Range	Ambient	-40		85	°C	1
Sensitivity	Untrimmed		333.87		LSB/°C	
Room Temp Offset	21°C		0		LSB	
POWER-ON RESET						
Supply Ramp Time (T _{RAMP})	Valid power-on RESET	0.01	20	100	ms	1
Start-up time for register read/write	From power-up		11	100	ms	1
I ² C ADDRESS	AD0 = 0 AD0 = 1		1101000 1101001			
DIGITAL INPUTS (FSYNC, AD0, SCLK, SDI, CS)						
V _{IH} , High Level Input Voltage		0.7*VDDIO			V	1
V _{IL} , Low Level Input Voltage				0.3*VDDIO	V	
C _i , Input Capacitance			< 10		pF	
DIGITAL OUTPUT (SDO, INT)						
V _{OH} , High Level Output Voltage	R _{LOAD} =1 MΩ;	0.9*VDDIO			V	1
V _{OL1} , LOW-Level Output Voltage	R _{LOAD} =1 MΩ;			0.1*VDDIO	V	
V _{OL,INT1} , INT Low-Level Output Voltage	OPEN=1, 0.3 mA sink Current			0.1	V	
Output Leakage Current	OPEN=1		100		nA	
t _{INT} , INT Pulse Width	LATCH_INT_EN=0		50		μs	
I ² C I/O (SCL, SDA)						
V _{IL} , LOW Level Input Voltage		-0.5V		0.3*VDDIO	V	1
V _{IH} , HIGH-Level Input Voltage		0.7*VDDIO		VDDIO + 0.5V	V	
V _{hys} , Hysteresis			0.1*VDDIO		V	
V _{OL} , LOW-Level Output Voltage	3 mA sink current	0		0.4	V	
I _{OL} , LOW-Level Output Current	V _{OL} =0.4V V _{OL} =0.6V		3 6		mA mA	
Output Leakage Current			100		nA	
t _{of} , Output Fall Time from V _{IHmax} to V _{ILmax}	C _b bus capacitance in pf	20+0.1C _b		250	ns	
AUXILLIARY I/O (AUX_CL, AUX_DA)						
V _{IL} , LOW-Level Input Voltage		-0.5V		0.3*VDDIO	V	1
V _{IH} , HIGH-Level Input Voltage		0.7* VDDIO		VDDIO + 0.5V	V	
V _{hys} , Hysteresis			0.1* VDDIO		V	
V _{OL1} , LOW-Level Output Voltage	VDDIO > 2V; 1 mA sink current	0		0.4	V	
V _{OL3} , LOW-Level Output Voltage	VDDIO < 2V; 1 mA sink current	0		0.2* VDDIO	V	
I _{OL} , LOW-Level Output Current	V _{OL} = 0.4V V _{OL} = 0.6V		3 6		mA mA	
Output Leakage Current			100		nA	
t _{of} , Output Fall Time from V _{IHmax} to V _{ILmax}	C _b bus capacitance in pF	20+0.1C _b		250	ns	

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
INTERNAL CLOCK SOURCE						
Clock Frequency Initial Tolerance	Accelerometer Only Mode	-5		+5	%	1
	Gyroscope or 6-Axis Mode WITHOUT Timebase Correction	-9		+9	%	1
	Gyroscope or 6-Axis Mode WITH Timebase Correction	-1		+1		
Frequency Variation over Temperature	Accelerometer Only Mode	-10		+10	%	1
	Gyroscope or 6-Axis Mode		±1		%	1

Table 5. A.C. Electrical Characteristics

NOTES:

1. Derived from validation or characterization of parts, not guaranteed in production.

Other Electrical Specifications

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
SERIAL INTERFACE						
SPI Operating Frequency, All Registers Read/Write	Low Speed Characterization		100 ±10%		kHz	
	High Speed Characterization		7 ±10%		MHz	
I ² C Operating Frequency	All registers, Fast-mode			400	kHz	
	All registers, Standard-mode			100	kHz	

Table 6. Other Electrical Specifications

NOTES:

1. Derived from validation or characterization of parts, not guaranteed in production.

3.5 I²C TIMING CHARACTERIZATION

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETERS	CONDITIONS	MIN	TYPICAL	MAX	UNITS	NOTES
I ² C TIMING		I ² C FAST-MODE				
f _{SCL} , SCL Clock Frequency				400	kHz	1, 2
t _{HD.STA} , (Repeated) START Condition Hold Time		0.6			μs	1, 2
t _{LOW} , SCL Low Period		1.3			μs	1, 2
t _{HIGH} , SCL High Period		0.6			μs	1, 2
t _{SU.STA} , Repeated START Condition Setup Time		0.6			μs	1, 2
t _{HD.DAT} , SDA Data Hold Time		0			μs	1, 2
t _{SU.DAT} , SDA Data Setup Time		100			ns	1, 2
t _r , SDA and SCL Rise Time	C _b bus cap. from 10 to 400 pF	20+0.1C _b		300	ns	1, 2
t _f , SDA and SCL Fall Time	C _b bus cap. from 10 to 400 pF	20+0.1C _b		300	ns	1, 2
t _{SU.STO} , STOP Condition Setup Time		0.6			μs	1, 2
t _{BUF} , Bus Free Time Between STOP and START Condition		1.3			μs	1, 2
C _b , Capacitive Load for each Bus Line			< 400		pF	1, 2
t _{VD.DAT} , Data Valid Time				0.9	μs	1, 2
t _{VD.ACK} , Data Valid Acknowledge Time				0.9	μs	1, 2

Table 7. I²C Timing Characteristics

NOTES:

1. Timing Characteristics apply to both Primary and Auxiliary I²C Bus.
2. Based on characterization of 5 parts over temperature and voltage as mounted on evaluation board or in sockets.

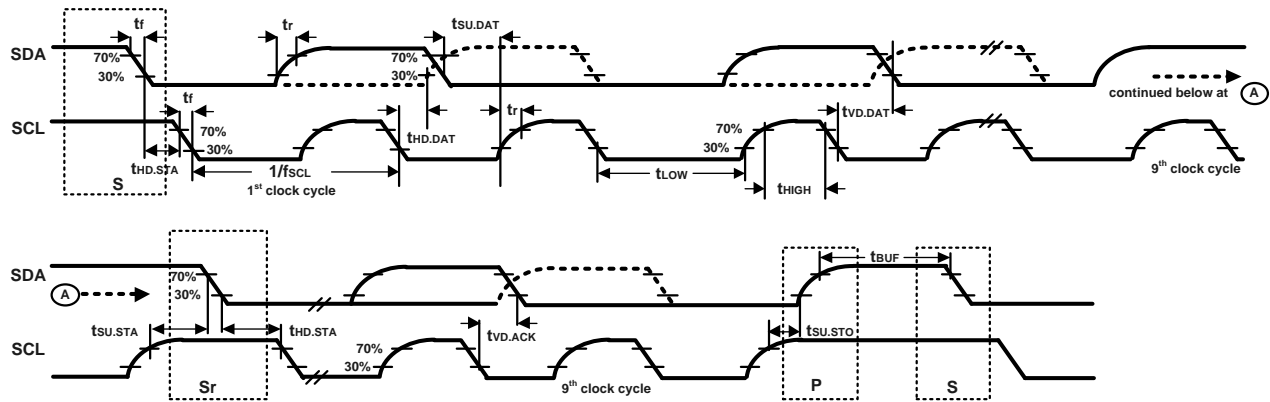


Figure 1. I²C Bus Timing Diagram

3.6 SPI TIMING CHARACTERIZATION

Typical Operating Circuit of section 4.2, VDD = 1.8V, VDDIO = 1.8V, T_A=25°C, unless otherwise noted.

PARAMETERS	CONDITIONS	MIN	TYPICAL	MAX	UNITS	NOTES
SPI TIMING						
f _{SCLK} , SCLK Clock Frequency				7	MHz	
t _{LOW} , SCLK Low Period		64			ns	
t _{HIGH} , SCLK High Period		64			ns	
t _{SU,CS} , CS Setup Time		8			ns	
t _{HD,CS} , CS Hold Time		500			ns	
t _{SU,SDI} , SDI Setup Time		5			ns	
t _{HD,SDI} , SDI Hold Time		7			ns	
t _{VD,SDO} , SDO Valid Time	C _{load} = 20 pF			59	ns	
t _{HD,SDO} , SDO Hold Time	C _{load} = 20 pF	6			ns	
t _{DIS,SDO} , SDO Output Disable Time				50	ns	

Table 8. SPI Timing Characteristics (7 MHz)

NOTES:

- Based on characterization of 5 parts over temperature and voltage as mounted on evaluation board or in sockets

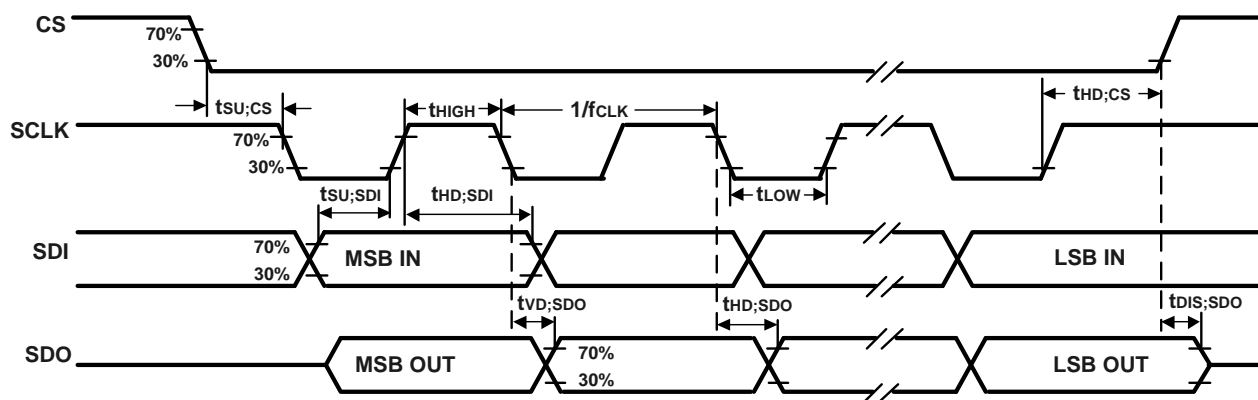


Figure 2. SPI Bus Timing Diagram

3.7 ABSOLUTE MAXIMUM RATINGS

Stress above those listed as “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to the absolute maximum ratings conditions for extended periods may affect device reliability.

PARAMETER	RATING
Supply Voltage, VDD	-0.5V to +4V
Supply Voltage, VDDIO	-0.3V to +2.5V
REGOUT	-0.5V to 2V
Input Voltage Level (AUX_DA, AD0, FSYNC, INT, SCL, SDA)	-0.5V to VDD + 0.5V
Acceleration (Any Axis, unpowered)	20,000g for 0.2 ms
Operating Temperature Range	-40°C to +105°C
Storage Temperature Range	-40°C to +125°C
Electrostatic Discharge (ESD) Protection	2kV (HBM); 200V (MM)
Latch-up	JEDEC Class II (2), 125°C ±100 mA

Table 9. Absolute Maximum Ratings

4 APPLICATIONS INFORMATION

4.1 PIN OUT DIAGRAM AND SIGNAL DESCRIPTION

PIN NUMBER	PIN NAME	PIN DESCRIPTION
7	AUX_CL	I ² C Master serial clock, for connecting to external sensors
8	VDDIO	Digital I/O supply voltage
9	AD0 / SDO	I ² C Slave Address LSB (AD0); SPI serial data output (SDO)
10	REGOUT	Regulator filter capacitor connection
11	FSYNC	Frame synchronization digital input. Connect to GND if unused
12	INT1	Interrupt 1
13	VDD	Power supply voltage
18	GND	Power supply ground
19	RESV	Reserved. Do not connect.
20	RESV	Reserved. Connect to GND.
21	AUX_DA	I ² C master serial data, for connecting to external sensors
22	nCS	Chip select (SPI mode only)
23	SCL / SCLK	I ² C serial clock (SCL); SPI serial clock (SCLK)
24	SDA / SDI	I ² C serial data (SDA); SPI serial data input (SDI)
1 – 6, 14 – 17	NC	Do not connect

Table 10. Signal Descriptions

NOTE: Power up with SCL/SCLK and nCS pins held low is not a supported use case. In case this power up approach is used, software reset is required using the PWR_MGMT_1 register, prior to initialization.

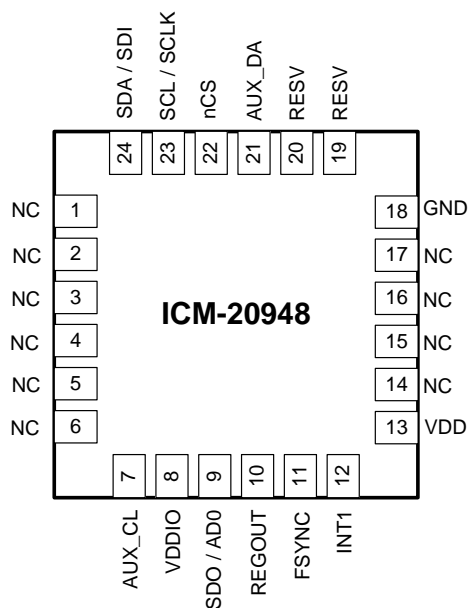


Figure 3. Pin out Diagram for ICM-20948 3 mm x 3 mm x 1 mm QFN

4.2 TYPICAL OPERATING CIRCUIT

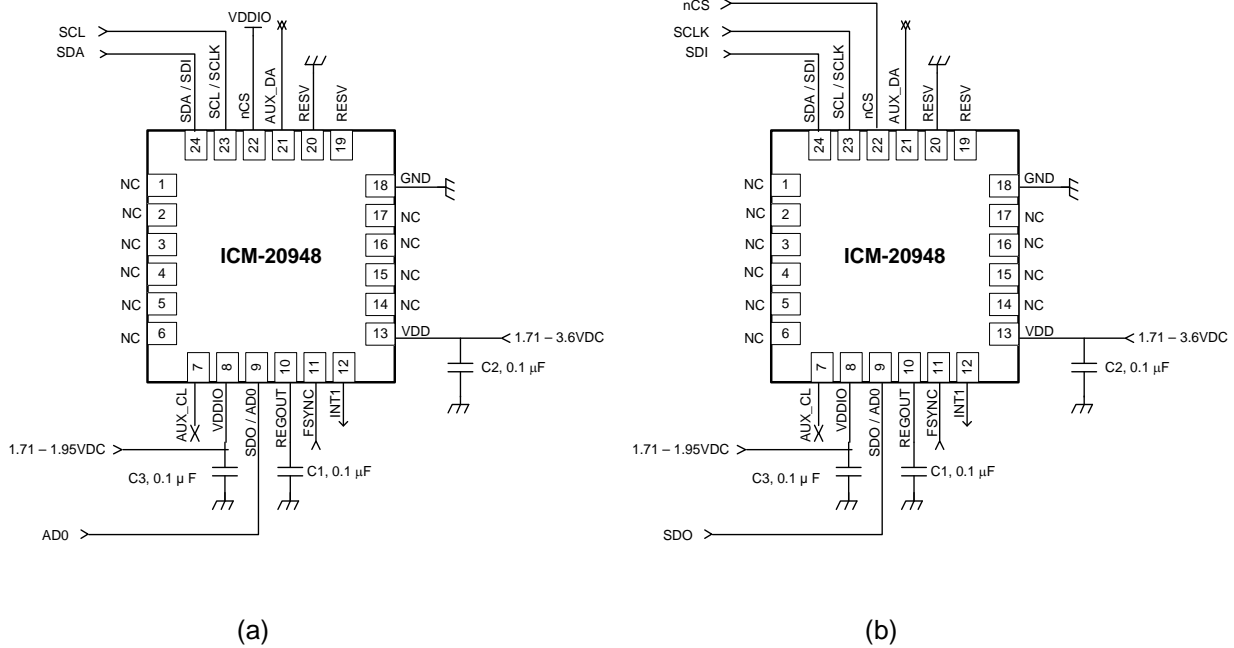


Figure 4. ICM-20948 Application Schematic (a) I²C operation (b) SPI operation

Note that the INT pin should be connected to a GPIO pin on the system processor that is capable of waking the system processor from suspend mode.

I²C lines are open drain and pullup resistors (e.g. 10 kΩ) are required.

4.3 BILL OF MATERIALS FOR EXTERNAL COMPONENTS

COMPONENT	LABEL	SPECIFICATION	QUANTITY
Regulator Filter Capacitor	C1	Ceramic, X7R, 0.1 µF ±10%, 2V	1
VDD Bypass Capacitor	C2	Ceramic, X7R, 0.1 µF ±10%, 4V	1
VDDIO Bypass Capacitor	C3	Ceramic, X7R, 0.1 µF ±10%, 4V	1

Table 11. Bill of Materials

4.4 EXPOSED DIE PAD PRECAUTIONS

InvenSense products have very low active and standby current consumption. The exposed die pad is not required for heat sinking, and should not be soldered to the PCB. Failure to adhere to this rule can induce performance changes due to package thermo-mechanical stress. There is no electrical connection between the pad and the CMOS.

4.5 BLOCK DIAGRAM

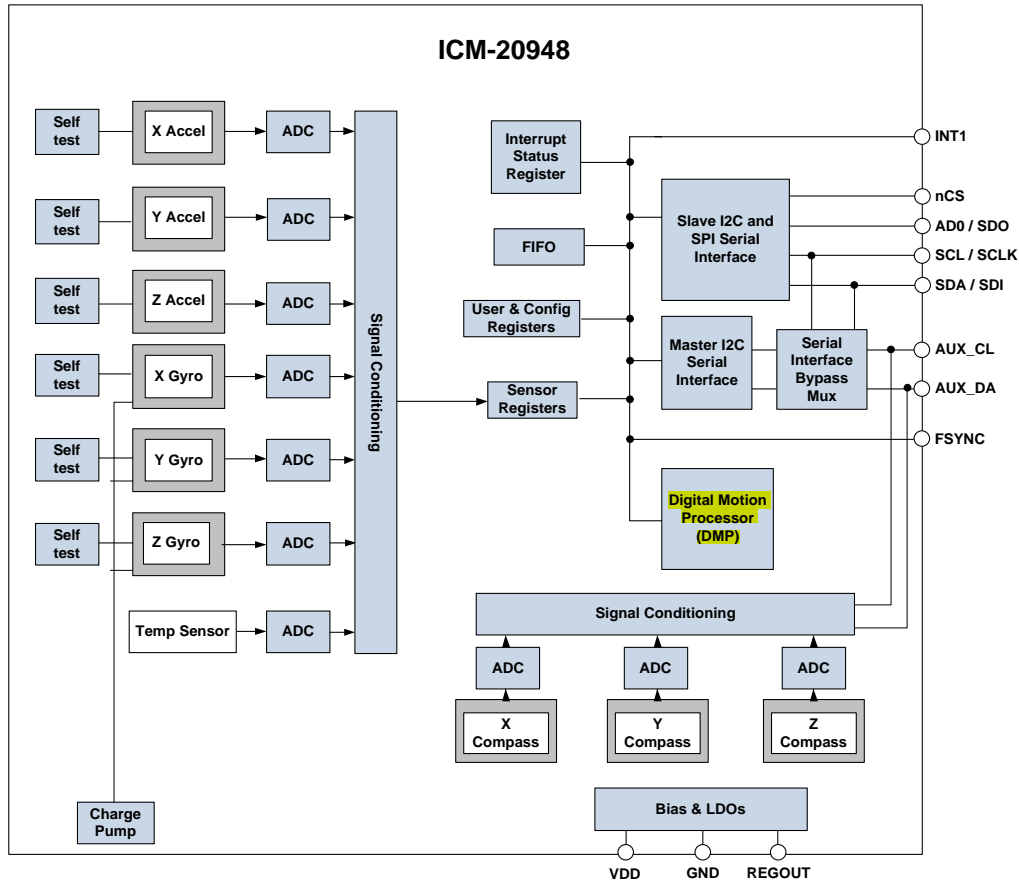


Figure 5. ICM-20948 Block Diagram

4.6 OVERVIEW

The ICM-20948 is comprised of the following key blocks and functions:

- Three-axis MEMS rate gyroscope sensor with 16-bit ADCs and signal conditioning
- Three-axis MEMS accelerometer sensor with 16-bit ADCs and signal conditioning
- Three-axis MEMS magnetometer sensor with 16-bit ADCs and signal conditioning
- Digital Motion Processor (DMP) engine
- Primary I²C and SPI serial communications interfaces
- Auxiliary I²C serial interface
- Gyroscope, Accelerometer, and Magnetometer Self-Test
- Clocking
- Sensor Data Registers
- FIFO
- FSYNC
- Interrupts
- Digital-Output Temperature Sensor
- Bias and LDOs
- Charge Pump
- Power Modes

4.7 THREE-AXIS MEMS GYROSCOPE WITH 16-BIT ADCS AND SIGNAL CONDITIONING

The ICM-20948 consists of three independent vibratory MEMS rate gyroscopes, which detect rotation about the X-, Y-, and Z-Axes. When the gyros are rotated about any of the sense axes, the Coriolis Effect causes a vibration that is detected by a capacitive pickoff. The resulting signal is amplified, demodulated, and filtered to produce a voltage that is proportional to the angular rate. This voltage is digitized using individual on-chip 16-bit Analog-to-Digital Converters (ADCs) to sample each axis. The full-scale range of the gyro sensors may be digitally programmed to ± 250 , ± 500 , ± 1000 , or ± 2000 degrees per second (dps).

4.8 THREE-AXIS MEMS ACCELEROMETER WITH 16-BIT ADCS AND SIGNAL CONDITIONING

The ICM-20948's 3-Axis accelerometer uses separate proof masses for each axis. Acceleration along a particular axis induces displacement on the corresponding proof mass, and capacitive sensors detect the displacement differentially. The ICM-20948's architecture reduces the accelerometers' susceptibility to fabrication variations as well as to thermal drift. When the device is placed on a flat surface, it will measure 0g on the X- and Y-axes and +1g on the Z-axis. The accelerometers' scale factor is calibrated at the factory and is nominally independent of supply voltage. Each sensor has a dedicated sigma-delta ADC for providing digital outputs. The full scale range of the digital output can be adjusted to $\pm 2g$, $\pm 4g$, $\pm 8g$, or $\pm 16g$.

4.9 THREE-AXIS MEMS MAGNETOMETER WITH 16-BIT ADCS AND SIGNAL CONDITIONING

The 3-axis magnetometer uses highly sensitive Hall sensor technology. The magnetometer portion of the IC incorporates magnetic sensors for detecting terrestrial magnetism in the X-, Y-, and Z-Axes, a sensor driving circuit, a signal amplifier chain, and an arithmetic circuit for processing the signal from each sensor. Each ADC has a 16-bit resolution and a full scale range of $\pm 4900 \mu\text{T}$.

4.10 DIGITAL MOTION PROCESSOR

The embedded Digital Motion Processor (DMP) within the ICM-20948 offloads computation of motion processing algorithms from the host processor. The DMP acquires data from accelerometers, gyroscopes, and additional third party sensors such as magnetometers, and processes the data. The resulting data can be read from the FIFO. The DMP has access to the external pins, which can be used for generating interrupts.

The purpose of the DMP is to offload both timing requirements and processing power from the host processor. Typically, motion processing algorithms should be run at a high rate, often around 200 Hz, in order to provide accurate results with low latency. This is required even if the application updates at a much lower rate; for example, a low power user interface may update as slowly as 5 Hz, but the motion processing should still run at 200 Hz. The DMP can be used to minimize power, simplify timing, simplify the software architecture, and save valuable MIPS on the host processor for use in applications.

4.11 PRIMARY I²C AND SPI SERIAL COMMUNICATIONS INTERFACES

The ICM-20948 communicates to a system processor using either a SPI or an I²C serial interface. The ICM-20948 always acts as a slave when communicating to the system processor. The LSB of the of the I²C slave address is set by pin 1 (AD0).

ICM-20948 Solution Using I²C Interface

In Figure 6, the system processor is an I²C master to the ICM-20948. In addition, the ICM-20948 is an I²C master to the optional external sensor. The ICM-20948 has limited capabilities as an I²C Master, and depends on the system processor to manage the initial configuration of any auxiliary sensors. The ICM-20948 has an interface bypass multiplexer, which connects the system processor I²C bus pins 23 and 24 (SCL and SDA) directly to the auxiliary sensor I²C bus pins 7 and 21 (AUX_CL and AUX_DA).

Once the auxiliary sensors have been configured by the system processor, the interface bypass multiplexer should be disabled so that the ICM-20948 auxiliary I²C master can take control of the sensor I²C bus and gather data from the auxiliary sensors.

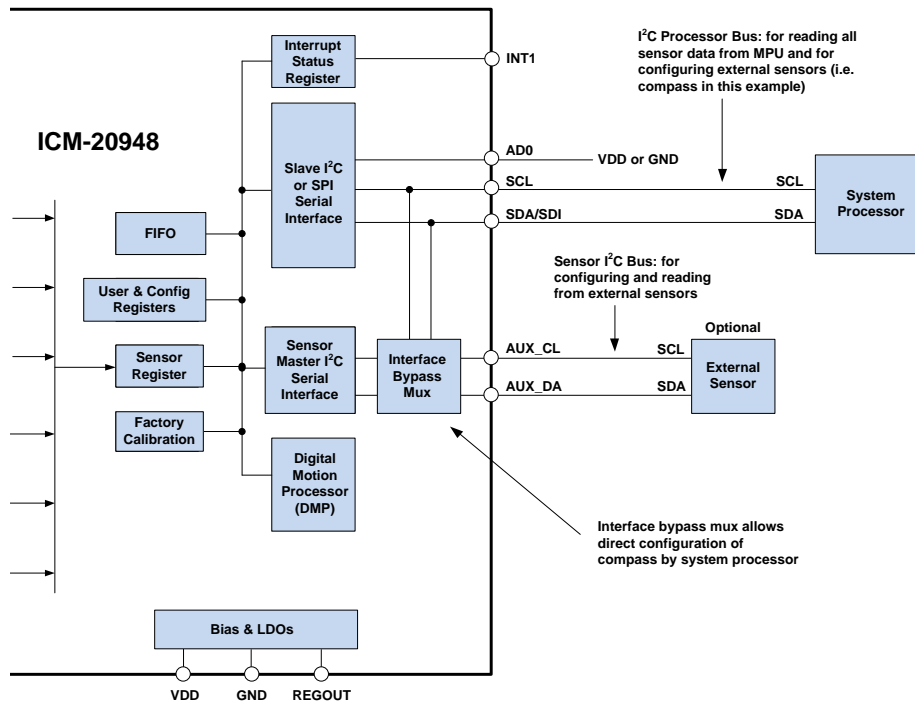


Figure 6. ICM-20948 Solution Using I²C Interface

ICM-20948 Solution Using SPI Interface

In Figure 7, the system processor is an SPI master to the ICM-20948. Pins 9, 22, 23, and 24 are used to support the SDO, nCS, SCLK, and SDI signals for SPI communications. Because these SPI pins are shared with the I²C slave pins (9, 23 and 24), the system processor cannot access the auxiliary I²C bus through the interface bypass multiplexer, which connects the processor I²C interface pins to the sensor I²C interface pins. Since the ICM-20948 has limited capabilities as an I²C Master, and depends on the system processor to manage the initial configuration of any auxiliary sensors, another method must be used for programming the sensors on the auxiliary sensor I²C bus pins 7 and 21 (AUX_CL and AUX_DA).

When using SPI communications between the ICM-20948 and the system processor, configuration of devices on the auxiliary I²C sensor bus can be achieved by using I²C Slaves 0-4 to perform read and write transactions on any device and register on the auxiliary I²C bus. The I²C Slave 4 interface can be used to perform only single byte read and write transactions. Once the external sensors have been configured, the ICM-20948 can perform single or multi-byte reads using the sensor I²C bus. The read results from the Slave 0-3 controllers can be written to the FIFO buffer as well as to the external sensor registers.

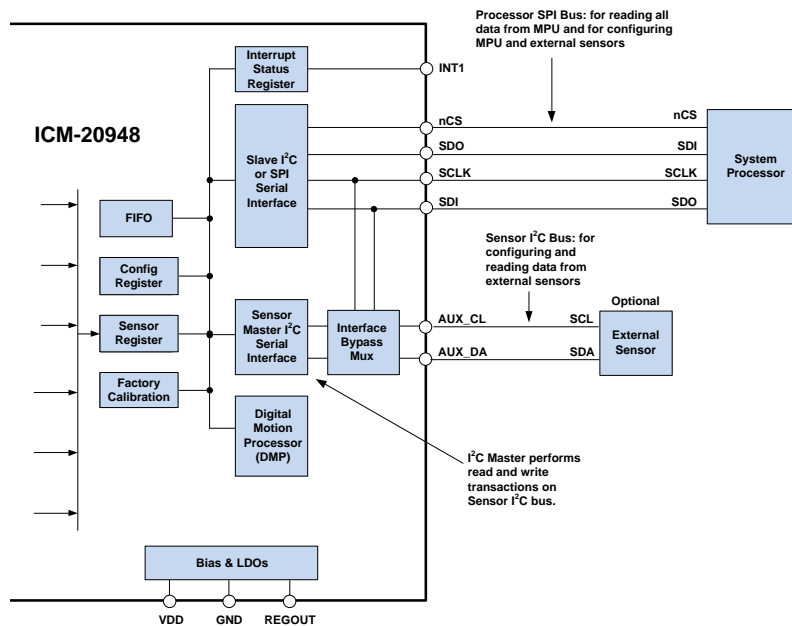


Figure 7. ICM-20948 Solution Using SPI Interface

4.12 AUXILIARY I²C SERIAL INTERFACE

The ICM-20948 has an auxiliary I²C bus for communicating to external sensors. This bus has two operating modes:

- **I²C Master Mode:** The ICM-20948 acts as a master to any external sensors connected to the auxiliary I²C bus
- **Pass-Through Mode:** The ICM-20948 directly connects the primary and auxiliary I²C buses together, allowing the system processor to directly communicate with any external sensors.

Auxiliary I²C Bus Modes of Operation:

- **I²C Master Mode:** Allows the ICM-20948 to directly access the data registers of external sensors. In this mode, the ICM-20948 directly obtains data from auxiliary sensors without intervention from the system applications processor. The I²C Master can be configured to read up to 24 bytes from up to 4 auxiliary sensors. A fifth sensor can be configured to work single byte read/write mode.
- **Pass-Through Mode:** Allows an external system processor to act as master and directly communicate to the external sensors connected to the auxiliary I²C bus pins (AUX_DA and AUX_CL). In this mode, the auxiliary I²C bus control logic of the ICM-20948 is disabled, and the auxiliary I²C pins AUX_CL and AUX_DA (pins 7 and 21) are connected to the main I²C bus (Pins 23 and 24) through analog switches internally. Pass-Through mode is useful for configuring the external sensors.

4.13 SELF-TEST

Self-test allows for the testing of the mechanical and electrical portions of the sensors. The self-test for each measurement axis can be activated by means of the gyroscope and accelerometer self-test registers.

When the self-test is activated, the electronics cause the sensors to be actuated and produce an output signal. The output signal is used to observe the self-test response.

The self-test response is defined as follows:

$$\text{SELF-TEST RESPONSE} = \text{SENSOR OUTPUT WITH SELF-TEST ENABLED} - \text{SENSOR OUTPUT WITHOUT SELF-TEST ENABLED}$$

The self-test response for each gyroscope axis is defined in the gyroscope specification table, while that for each accelerometer axis is defined in the accelerometer specification table.

When the value of the self-test response is within the specified min/max limits, the part has passed self-test. When the self-test response exceeds the min/max values, the part is deemed to have failed self-test. It is recommended to use InvenSense MotionApps software for executing self-test.

4.14 CLOCKING

The internal system clock sources include: (1) an internal relaxation oscillator, and (2) a PLL with MEMS gyroscope oscillator as the reference clock. With the recommended clock selection setting (CLKSEL = 1), the best clock source for optimum sensor performance and power consumption will be automatically selected based on the power mode. Specifically, the internal relaxation oscillator will be selected when operating in accelerometer only mode, while the PLL will be selected whenever gyroscope is on, which includes gyroscope and 6-axis modes.

As clock accuracy is critical to the preciseness of distance and angle calculations performed by DMP, it should be noted that the internal relaxation oscillator and PLL show different performances in some aspects. The internal relaxation oscillator is trimmed to have a consistent operating frequency at room temperature, while the PLL clock frequency varies from part to part. The PLL frequency deviation from the nominal value in percentage is captured in register TIMEBASE_CORRECTION_PLL (detailed in section 12.5), and users can factor it in during distance and angle calculations to not sacrifice accuracy. Other than that, PLL has better frequency stability and lower frequency variation over temperature than the internal relaxation oscillator.

4.15 SENSOR DATA REGISTERS

The sensor data registers contain the latest gyro, accelerometer, auxiliary sensor, and temperature measurement data. They are read-only registers, and are accessed via the serial interface. Data from these registers may be read anytime.

4.16 FIFO

The ICM-20948 contains a FIFO of size 512 bytes (FIFO size will vary depending on DMP feature-set) that is accessible via the Serial Interface. The FIFO configuration register determines which data is written into the FIFO. Possible choices include gyro data, accelerometer data, temperature readings, auxiliary sensor readings, and FSYNC input.

A FIFO counter keeps track of how many bytes of valid data are contained in the FIFO. The FIFO register supports burst reads. The interrupt function may be used to determine when new data is available.

For further information regarding the FIFO, please refer to the Section 7.

4.17 FSYNC

The FSYNC pin can be used from an external interrupt source to wake up the device from sleep. It is particularly useful in EIS applications to synchronize the gyroscope ODR with external inputs from an imaging sensor. Connecting the VSYNC or HSYNC pin of the image sensor subsystem to FSYNC on ICM-20948 allows timing synchronization between the two otherwise unconnected subsystems.

An FSYNC_ODR delay time register is used to capture the delay between an FSYNC pulse and the very next gyroscope data ready pulse.

4.18 INTERRUPTS

Interrupt functionality is configured via the Interrupt Configuration register. Items that are configurable include the INT pin configuration, the interrupt latching and clearing method, and triggers for the interrupt. Section 5 provides a summary of interrupt sources. The interrupt status can be read from the Interrupt Status register.

For further information regarding interrupts, please refer to Section 7.

4.19 DIGITAL-OUTPUT TEMPERATURE SENSOR

An on-chip temperature sensor and ADC are used to measure the ICM-20948 die temperature. The readings from the ADC can be read from the FIFO or the Sensor Data registers.

4.20 BIAS AND LDOS

The bias and LDO section generates the internal supply and the reference voltages and currents required by the ICM-20948. Its two inputs are an unregulated VDD and a VDDIO logic reference supply voltage. The LDO output is bypassed by a capacitor at REGOUT. For further details on the capacitor, please refer to the Bill of Materials for External Components.

4.21 CHARGE PUMP

An on-chip charge pump generates the high voltage required for the MEMS oscillators.

4.22 POWER MODES

Table 12 lists the user-accessible power modes for ICM-20948.

MODE	NAME	GYRO	ACCEL	MAGNETOMETER	DMP
1	Sleep Mode	Off	Off	Off	Off
2	Low-Power Accelerometer Mode	Off	Duty-Cycled	Off	On or Off
3	Low-Noise Accelerometer Mode	Off	On	Off	On or Off
4	Gyroscope Mode	On	Off	Off	On or Off
5	Magnetometer Mode	Off	Off	On	On or Off
6	Accel + Gyro Mode	On	On	Off	On or Off
7	Accel + Magnetometer Mode	Off	On	On	On or Off
8	9-Axis Mode	On	On	On	On or Off

Table 12. Power Modes for ICM-20948

5 PROGRAMMABLE INTERRUPTS

The ICM-20948 has a programmable interrupt system which can generate an interrupt signal on the INT pin. Status flags indicate the source of an interrupt. Interrupt sources may be enabled and disabled individually. Table 13 lists the interrupt sources.

INTERRUPT SOURCE
DMP Interrupt
Wake on Motion Interrupt
PLL RDY Interrupt
I2C Master Interrupt
Raw Data Ready Interrupt
FIFO Overflow Interrupt
FIFO Watermark Interrupt

Table 13. Interrupt Sources

6 DIGITAL INTERFACE

6.1 I²C AND SPI SERIAL INTERFACES

The internal registers and memory of the ICM-20948 can be accessed using either I²C at 400 kHz or SPI at 7 MHz. SPI operates in four-wire mode.

PIN NUMBER	PIN NAME	PIN DESCRIPTION
9	AD0 / SDO	I ² C Slave Address LSB (AD0); SPI serial data output (SDO)
22	nCS	Chip select (SPI mode only)
23	SCL / SCLK	I ² C serial clock (SCL); SPI serial clock (SCLK)
24	SDA / SDI	I ² C serial data (SDA); SPI serial data input (SDI)

Table 14. Serial Interface

NOTE: To prevent switching into I²C mode when using SPI, the I²C interface should be disabled by setting the *I2C_IF_DIS* configuration bit. Setting this bit should be performed immediately after waiting for the time specified by the “Start-Up Time for Register Read/Write” in Section 6.3.

For further information regarding the *I2C_IF_DIS* bit, please refer to Section 7.

6.2 I²C INTERFACE

I²C is a two-wire interface comprised of the signals serial data (SDA) and serial clock (SCL). In general, the lines are open-drain and bi-directional. In a generalized I²C interface implementation, attached devices can be a master or a slave. The master device puts the slave address on the bus, and the slave device with the matching address acknowledges the master.

The ICM-20948 always operates as a slave device when communicating to the system processor, which thus acts as the master. SDA and SCL lines typically need pull-up resistors to VDD. The maximum bus speed is 400 kHz.

The slave address of the ICM-20948 is b110100X which is 7 bits long. The LSB bit of the 7-bit address is determined by the logic level on pin AD0. **This allows two ICM-20948s to be connected to the same I²C bus.** When used in this configuration, the address of the one of the devices should be b1101000 (pin AD0 is logic low) and the address of the other should be b1101001 (pin AD0 is logic high).

6.3 I²C COMMUNICATIONS PROTOCOL

START (S) and STOP (P) Conditions

Communication on the I²C bus starts when the master puts the START condition (S) on the bus, which is defined as a HIGH-to-LOW transition of the SDA line while SCL line is HIGH (see figure below). The bus is considered to be busy until the master puts a STOP condition (P) on the bus, which is defined as a LOW to HIGH transition on the SDA line while SCL is HIGH (see figure below).

Additionally, the bus remains busy if a repeated START (Sr) is generated instead of a STOP condition.

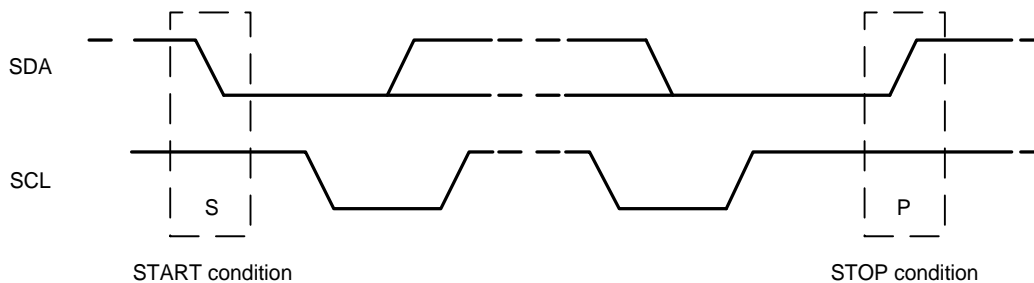


Figure 8. START and STOP Conditions

Data Format / Acknowledge

I²C data bytes are defined to be 8-bits long. There is no restriction to the number of bytes transmitted per data transfer. **Each byte transferred must be followed by an acknowledge (ACK) signal.** The clock for the acknowledge signal is generated by the master, while the receiver generates the actual acknowledge signal by pulling down SDA and holding it low during the HIGH portion of the acknowledge clock pulse.

If a slave is busy and cannot transmit or receive another byte of data until some other task has been performed, it can hold SCL LOW, thus forcing the master into a wait state. Normal data transfer resumes when the slave is ready, and releases the clock line (refer to the following figure).

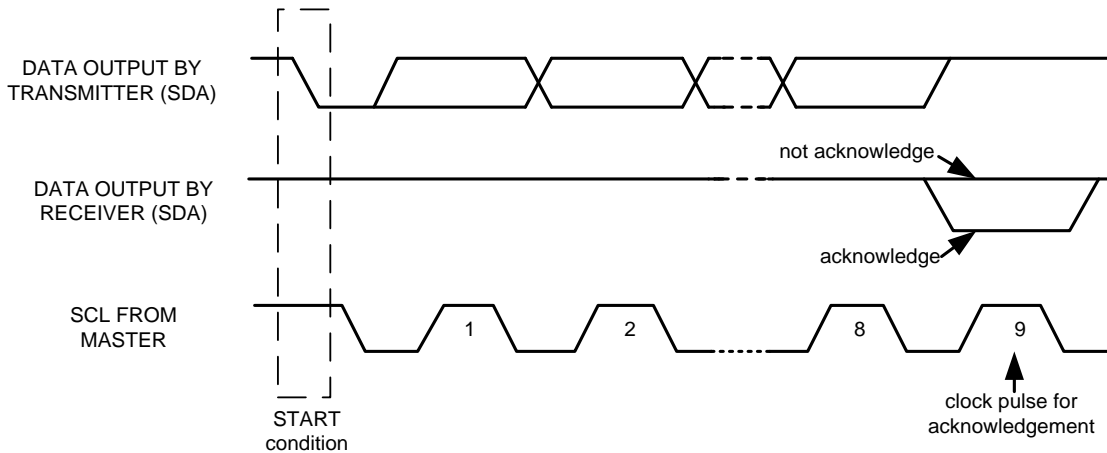


Figure 9. Acknowledge on the I²C Bus

Communications

After beginning communications with the START condition (S), the master sends a 7-bit slave address followed by an 8th bit, the read/write bit. The read/write bit indicates whether the master is receiving data from or is writing to the slave device. Then, the master releases the SDA line and waits for the acknowledge signal (ACK) from the slave device. Each byte transferred must be followed by an acknowledge bit. To acknowledge, the slave device pulls the SDA line LOW and keeps it LOW for the high period of the SCL line. Data transmission is always terminated by the master with a STOP condition (P), thus freeing the communications line. However, the master can generate a repeated START condition (Sr), and address another slave without first generating a STOP condition (P). A LOW to HIGH transition on the SDA line while SCL is HIGH defines the stop condition. All SDA changes should take place when SCL is low, with the exception of start and stop conditions.

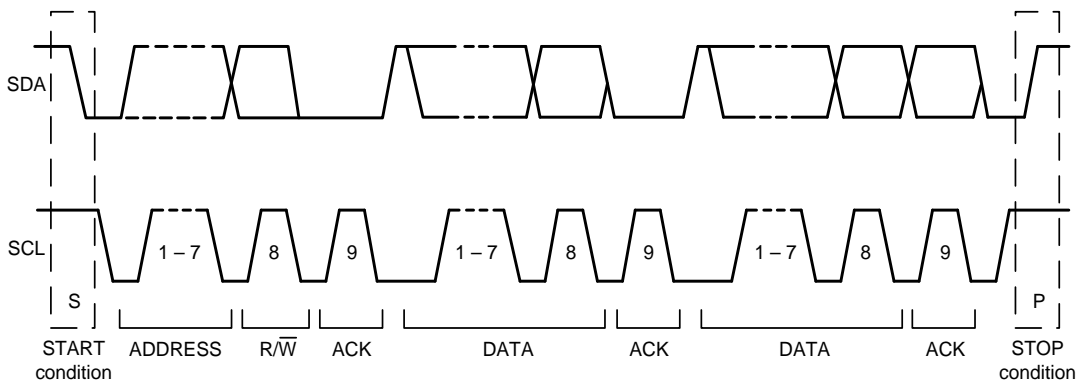


Figure 10. Complete I²C Data Transfer

To write the internal ICM-20948 registers, the master transmits the start condition (S), followed by the I²C address and the write bit (0). At the 9th clock cycle (when the clock is high), the ICM-20948 acknowledges the transfer. Then the master puts the register address (RA) on the bus. After the ICM-20948 acknowledges the reception of the register address, the master puts the register data onto the bus. This is followed by the ACK signal, and data transfer may be concluded by the stop condition (P). To write multiple bytes after the last ACK signal, the master can continue outputting data rather than transmitting a stop signal. In this case, the ICM-20948 automatically increments the register address and loads the data to the appropriate register. The following figures show single and two-byte write sequences.

Single-Byte Write Sequence

Master	S	AD+W		RA		DATA		P
Slave			ACK		ACK		ACK	

Burst Write Sequence

Master	S	AD+W		RA		DATA		DATA		P
Slave			ACK		ACK		ACK		ACK	

To read the internal ICM-20948 registers, the master sends a start condition, followed by the I²C address and a write bit, and then the register address that is going to be read. Upon receiving the ACK signal from the ICM-20948, the master transmits a start signal followed by the slave address and read bit. As a result, the ICM-20948 sends an ACK signal and the data. The communication ends with a not acknowledge (NACK) signal and a stop bit from master. The NACK condition is defined such that the SDA line remains high at the 9th clock cycle. The following figures show single and two-byte read sequences.

Single-Byte Read Sequence

Master	S	AD+W		RA		S	AD+R			NACK	P
Slave			ACK		ACK			ACK	DATA		

Burst Read Sequence

Master	S	AD+W		RA		S	AD+R			ACK		NACK	P
Slave			ACK		ACK			ACK	DATA		DATA		

6.4 I²C TERMS

SIGNAL	DESCRIPTION
S	Start Condition: SDA goes from high to low while SCL is high
AD	Slave I ² C address
W	Write bit (0)
R	Read bit (1)
ACK	Acknowledge: SDA line is low while the SCL line is high at the 9 th clock cycle
NACK	Not-Acknowledge: SDA line stays high at the 9 th clock cycle
RA	ICM-20948 internal register address
DATA	Transmit or received data
P	Stop condition: SDA going from low to high while SCL is high

Table 15. I²C Terms

6.5 SPI INTERFACE

SPI is a 4-wire synchronous serial interface that uses two control lines and two data lines. The ICM-20948 always operates as a Slave device during standard Master-Slave SPI operation.

With respect to the Master, the Serial Clock output (SCLK), the Serial Data Output (SDO) and the Serial Data Input (SDI) are shared among the Slave devices. Each SPI slave device requires its own Chip Select (CS) line from the master.

CS goes low (active) at the start of transmission and goes back high (inactive) at the end. Only one CS line is active at a time, ensuring that only one slave is selected at any given time. The CS lines of the non-selected slave devices are held high, causing their SDO lines to remain in a high-impedance (high-z) state so that they do not interfere with any active devices.

SPI Operational Features

1. Data is delivered MSB first and LSB last
2. Data is latched on the rising edge of SCLK
3. Data should be transitioned on the falling edge of SCLK
4. The maximum frequency of SCLK is 7MHz
5. SPI read and write operations are completed in 16 or more clock cycles (two or more bytes). The first byte contains the SPI Address, and the following byte(s) contain(s) the SPI data. The first bit of the first byte contains the Read/Write bit and indicates the Read (1) or Write (0) operation. The following 7 bits contain the Register Address. In cases of multiple-byte Read/Writes, data is two or more bytes:

SPI Address format

MSB							LSB
R/W	A6	A5	A4	A3	A2	A1	A0

SPI Data format

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0

6. Supports Single or Burst Read/Writes.

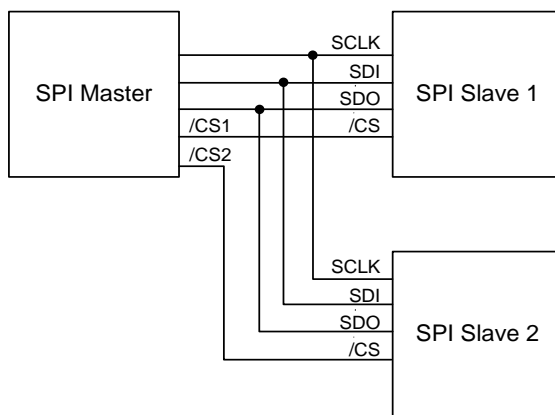


Figure 11. Typical SPI Master / Slave Configuration

7 REGISTER MAP FOR GYROSCOPE AND ACCELEROMETER

The following table lists the register map for the ICM-20948, for user banks 0, 1, 2, 3.

7.1 USER BANK 0 REGISTER MAP

ADDR (HEX)	ADDR (DEC.)	REGISTER NAME	SERIAL I/F	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00	0	WHO_AM_I	R	WHO_AM_I[7:0]							
03	3	USER_CTRL	R/W	DMP_EN	FIFO_EN	I2C_MST_EN	I2C_IF_DIS	DMP_RST	SRAM_RST	I2C_MST_RST	-
05	5	LP_CONFIG	R/W		I2C_MST_CYCLE	ACCEL_CYCLE	GYRO_CYCLE	-			
06	6	PWR_MGMT_1	R/W	DEVICE_RESET	SLEEP	LP_EN	-	TEMP_DIS	CLKSEL[2:0]		
07	7	PWR_MGMT_2	R/W	-		DISABLE_ACCEL			DISABLE_GYRO		
0F	15	INT_PIN_CFG	R/W	INT1_ACTL	INT1_OPEN	INT1_LATCH_INT_EN	INT_ANYRD_2CLEAR	ACTL_FSYNC	FSYNC_INT_MODE_EN	BYPASS_EN	-
10	16	INT_ENABLE	R/W	REG_WOF_EN	-			WOM_INT_EN	PLL_RDY_EN	DMP_INT1_EN	I2C_MST_INT_EN
11	17	INT_ENABLE_1	R/W	-							RAW_DATA_O_RDY_EN
12	18	INT_ENABLE_2	R/W	-			FIFO_OVERFLOW_EN[4:0]				
13	19	INT_ENABLE_3	R/W	-			FIFO_WM_EN[4:0]				
17	23	I2C_MST_STATUS	R/C	PASS_THROUGH	I2C_SLV4_DONE	I2C_LOST_ARB	I2C_SLV4_NACK	I2C_SLV3_NACK	I2C_SLV2_NACK	I2C_SLV1_NACK	I2C_SLV0_NACK
19	25	INT_STATUS	R/C	-				WOM_INT	PLL_RDY_INT	DMP_INT1	I2C_MST_INT
1A	26	INT_STATUS_1	R/C	-							RAW_DATA_O_RDY_INT
1B	27	INT_STATUS_2	R/C	-			FIFO_OVERFLOW_INT[4:0]				
1C	28	INT_STATUS_3	R/C	-			FIFO_WM_INT[4:0]				
28	40	DELAY_TIMEH	R	DELAY_TIMEH[7:0]							
29	41	DELAY_TIMEL	R	DELAY_TIMEL[7:0]							
2D	45	ACCEL_XOUT_H	R	ACCEL_XOUT_H[7:0]							
2E	46	ACCEL_XOUT_L	R	ACCEL_XOUT_L[7:0]							
2F	47	ACCEL_YOUT_H	R	ACCEL_YOUT_H[7:0]							
30	48	ACCEL_YOUT_L	R	ACCEL_YOUT_L[7:0]							
31	49	ACCEL_ZOUT_H	R	ACCEL_ZOUT_H[7:0]							
32	50	ACCEL_ZOUT_L	R	ACCEL_ZOUT_L[7:0]							
33	51	GYRO_XOUT_H	R	GYRO_XOUT_H[7:0]							
34	52	GYRO_XOUT_L	R	GYRO_XOUT_L[7:0]							
35	53	GYRO_YOUT_H	R	GYRO_YOUT_H[7:0]							
36	54	GYRO_YOUT_L	R	GYRO_YOUT_L[7:0]							
37	55	GYRO_ZOUT_H	R	GYRO_ZOUT_H[7:0]							
38	56	GYRO_ZOUT_L	R	GYRO_ZOUT_L[7:0]							
39	57	TEMP_OUT_H	R	TEMP_OUT_H[7:0]							
3A	58	TEMP_OUT_L	R	TEMP_OUT_L[7:0]							
3B	59	EXT_SLV_SENS_DATA_00	R	EXT_SLV_SENS_DATA_00[7:0]							
3C	60	EXT_SLV_SENS_DATA_01	R	EXT_SLV_SENS_DATA_01[7:0]							
3D	61	EXT_SLV_SENS_DATA_02	R	EXT_SLV_SENS_DATA_02[7:0]							
3E	62	EXT_SLV_SENS_DATA_03	R	EXT_SLV_SENS_DATA_03[7:0]							
3F	63	EXT_SLV_SENS_DATA_04	R	EXT_SLV_SENS_DATA_04[7:0]							
40	64	EXT_SLV_SENS_DATA_05	R	EXT_SLV_SENS_DATA_05[7:0]							
41	65	EXT_SLV_SENS_DATA_06	R	EXT_SLV_SENS_DATA_06[7:0]							
42	66	EXT_SLV_SENS_DATA_07	R	EXT_SLV_SENS_DATA_07[7:0]							
43	67	EXT_SLV_SENS_DATA_08	R	EXT_SLV_SENS_DATA_08[7:0]							

ADDR (HEX)	ADDR (DEC.)	REGISTER NAME	SERIAL I/F	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
44	68	EXT_SLV_SENS_DATA_09	R	EXT_SLV_SENS_DATA_09[7:0]							
45	69	EXT_SLV_SENS_DATA_10	R	EXT_SLV_SENS_DATA_10[7:0]							
46	70	EXT_SLV_SENS_DATA_11	R	EXT_SLV_SENS_DATA_11[7:0]							
47	71	EXT_SLV_SENS_DATA_12	R	EXT_SLV_SENS_DATA_12[7:0]							
48	72	EXT_SLV_SENS_DATA_13	R	EXT_SLV_SENS_DATA_13[7:0]							
49	73	EXT_SLV_SENS_DATA_14	R	EXT_SLV_SENS_DATA_14[7:0]							
4A	74	EXT_SLV_SENS_DATA_15	R	EXT_SLV_SENS_DATA_15[7:0]							
4B	75	EXT_SLV_SENS_DATA_16	R	EXT_SLV_SENS_DATA_16[7:0]							
4C	76	EXT_SLV_SENS_DATA_17	R	EXT_SLV_SENS_DATA_17[7:0]							
4D	77	EXT_SLV_SENS_DATA_18	R	EXT_SLV_SENS_DATA_18[7:0]							
4E	78	EXT_SLV_SENS_DATA_19	R	EXT_SLV_SENS_DATA_19[7:0]							
4F	79	EXT_SLV_SENS_DATA_20	R	EXT_SLV_SENS_DATA_20[7:0]							
50	80	EXT_SLV_SENS_DATA_21	R	EXT_SLV_SENS_DATA_21[7:0]							
51	81	EXT_SLV_SENS_DATA_22	R	EXT_SLV_SENS_DATA_22[7:0]							
52	82	EXT_SLV_SENS_DATA_23	R	EXT_SLV_SENS_DATA_23[7:0]							
66	102	FIFO_EN_1	R/W	-				SLV_3_FIFO_EN	SLV_2_FIFO_EN	SLV_1_FIFO_EN	SLV_0_FIFO_EN
67	103	FIFO_EN_2	R/W	-			ACCEL_FIFO_EN	GYRO_Z_FIFO_EN	GYRO_Y_FIFO_EN	GYRO_X_FIFO_EN	TEMP_FIFO_EN
68	104	FIFO_RST	R/W	-			FIFO_RESET[4:0]				
69	105	FIFO_MODE	R/W	-			FIFO_MODE[4:0]				
70	112	FIFO_COUNTH	R	-			FIFO_CNT[12:8]				
71	113	FIFO_COUNTL	R	FIFO_CNT[7:0]							
72	114	FIFO_R_W	R/W	FIFO_R_W[7:0]							
74	116	DATA_RDY_STATUS	R/C	WOF_STATU S	-			RAW_DATA_RDY[3:0]			
76	118	FIFO_CFG	R/W	-							FIFO_CFG
7F	127	REG_BANK_SEL	R/W	-		USER_BANK[1:0]		-			

7.2 USER BANK 1 REGISTER MAP

Addr (Hex)	Addr (Dec.)	Register Name	Serial I/F	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
02	2	SELF_TEST_X_GYRO	R/W	XG_ST_DATA[7:0]							
03	3	SELF_TEST_Y_GYRO	R/W	YG_ST_DATA[7:0]							
04	4	SELF_TEST_Z_GYRO	R/W	ZG_ST_DATA[7:0]							
0E	14	SELF_TEST_X_ACCEL	R/W	XA_ST_DATA[7:0]							
0F	15	SELF_TEST_Y_ACCEL	R/W	YA_ST_DATA[7:0]							
10	16	SELF_TEST_Z_ACCEL	R/W	ZA_ST_DATA[7:0]							
14	20	XA_OFFSETS_H	R/W	XA_OFFSETS[14:7]							
15	21	XA_OFFSETS_L	R/W	XA_OFFSETS[6:0]							-
17	23	YA_OFFSETS_H	R/W	YA_OFFSETS[14:7]							
18	24	YA_OFFSETS_L	R/W	YA_OFFSETS[6:0]							-
1A	26	ZA_OFFSETS_H	R/W	ZA_OFFSETS[14:7]							
1B	27	ZA_OFFSETS_L	R/W	ZA_OFFSETS[6:0]							-

Addr (Hex)	Addr (Dec.)	Register Name	Serial I/F	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
28	40	TIMEBASE_CORRECTIO N_PLL	R/W	TBC_PLL[7:0]							
7F	127	REG_BANK_SEL	R/W	-		USER_BANK[1:0]		-			

7.3 USER BANK 2 REGISTER MAP

ADDR (HEX)	ADDR (DEC.)	REGISTER NAME	SERIAL I/F	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0	
00	0	GYRO_SMP_LRT_DIV	R/W	GYRO_SMP_LRT_DIV[7:0]								
01	1	GYRO_CONFIG_1	R/W	-		GYRO_DLPCFG[2:0]			GYRO_FS_SEL[1:0]		GYRO_FCHOI CE	
02	2	GYRO_CONFIG_2	R/W	-		XGYRO_CTEN	YGYRO_CTEN	ZGYRO_CTEN	GYRO_AVGCFG[2:0]			
03	3	XG_OFFS_USRH	R/W	X_OFFS_USER[15:8]								
04	4	XG_OFFS_USRL	R/W	X_OFFS_USER[7:0]								
05	5	YG_OFFS_USRH	R/W	Y_OFFS_USER[15:8]								
06	6	YG_OFFS_USRL	R/W	Y_OFFS_USER[7:0]								
07	7	ZG_OFFS_USRH	R/W	Z_OFFS_USER[15:8]								
08	8	ZG_OFFS_USRL	R/W	Z_OFFS_USER[7:0]								
09	9	ODR_ALIGN_EN	R/W	-								ODR_ALIGN_ EN
10	16	ACCEL_SMP_LRT_DIV_1	R/W	-				ACCEL_SMP_LRT_DIV[11:8]				
11	17	ACCEL_SMP_LRT_DIV_2	R/W	ACCEL_SMP_LRT_DIV[7:0]								
12	18	ACCEL_INTEL_CTRL	R/W	-							ACCEL_INTEL_ EN	ACCEL_INTEL_ MODE_INT
13	19	ACCEL_WOM_THR	R/W	WOM_THRESHOLD[7:0]								
14	20	ACCEL_CONFIG	R/W	-		ACCEL_DLPCFG[2:0]			ACCEL_FS_SEL[1:0]		ACCEL_FCHOI CE	
15	21	ACCEL_CONFIG_2	R/W	-			AX_ST_EN_R EG	AY_ST_EN_R EG	AZ_ST_EN_R EG	DEC3_CFG[1:0]		
52	82	FSYNC_CONFIG	R/W	DELAY_TIME_ EN	-	WOF DEGLIT CH_EN	WOF_EDGE_I NT	EXT_SYNC_SET[3:0]				
53	83	TEMP_CONFIG	R/W	-					TEMP_DLPCFG[2:0]			
54	84	MOD_CTRL_USR	R/W	-								REG_LP_DMP_ EN
7F	127	REG_BANK_SEL	R/W	-		USER_BANK[1:0]		-				

7.4 USER BANK 3 REGISTER MAP

ADDR (HEX)	ADDR (DEC.)	REGISTER NAME	SERIAL I/F	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
00	0	I2C_MST_ODR_CONFIG	R/W	-				I2C_MST_ODR_CONFIG[3:0]			
01	1	I2C_MST_CTRL	R/W	MULT_MST_EN	-		I2C_MST_P_NSR	I2C_MST_CLK[3:0]			
02	2	I2C_MST_DELAY_CTRL	R/W	DELAY_ES_SHADOW	-		I2C_SLV4_DELAY_EN	I2C_SLV3_DELAY_EN	I2C_SLV2_DELAY_EN	I2C_SLV1_DELAY_EN	I2C_SLV0_DELAY_EN
03	3	I2C_SLV0_ADDR	R/W	I2C_SLV0_RNW	I2C_ID_0[6:0]						
04	4	I2C_SLV0_REG	R/W	I2C_SLV0_REG[7:0]							
05	5	I2C_SLV0_CTRL	R/W	I2C_SLV0_EN	I2C_SLV0_BYTE_SW	I2C_SLV0_REG_DIS	I2C_SLV0_GRP	I2C_SLV0_LEN[3:0]			
06	6	I2C_SLV0_DO	R/W	I2C_SLV0_DO[7:0]							
07	7	I2C_SLV1_ADDR	R/W	I2C_SLV1_RNW	I2C_ID_1[6:0]						
08	8	I2C_SLV1_REG	R/W	I2C_SLV1_REG[7:0]							
09	9	I2C_SLV1_CTRL	R/W	I2C_SLV1_EN	I2C_SLV1_BYTE_SW	I2C_SLV1_REG_DIS	I2C_SLV1_GRP	I2C_SLV1_LEN[3:0]			

ADDR (HEX)	ADDR (DEC.)	REGISTER NAME	SERIAL I/F	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0A	10	I2C_SLV1_DO	R/W	I2C_SLV1_DO[7:0]							
0B	11	I2C_SLV2_ADDR	R/W	I2C_SLV2_RN W	I2C_ID_2[6:0]						
0C	12	I2C_SLV2_REG	R/W	I2C_SLV2_REG[7:0]							
0D	13	I2C_SLV2_CTRL	R/W	I2C_SLV2_EN	I2C_SLV2_BY TE_SW	I2C_SLV2_RE G_DIS	I2C_SLV2_GR P	I2C_SLV2 LENG[3:0]			
0E	14	I2C_SLV2_DO	R/W	I2C_SLV2_DO[7:0]							
0F	15	I2C_SLV3_ADDR	R/W	I2C_SLV3_RN W	I2C_ID_3[6:0]						
10	16	I2C_SLV3_REG	R/W	I2C_SLV3_REG[7:0]							
11	17	I2C_SLV3_CTRL	R/W	I2C_SLV3_EN	I2C_SLV3_BY TE_SW	I2C_SLV3_RE G_DIS	I2C_SLV3_GR P	I2C_SLV3 LENG[3:0]			
12	18	I2C_SLV3_DO	R/W	I2C_SLV3_DO[7:0]							
13	19	I2C_SLV4_ADDR	R/W	I2C_SLV4_RN W	I2C_ID_4[6:0]						
14	20	I2C_SLV4_REG	R/W	I2C_SLV4_REG[7:0]							
15	21	I2C_SLV4_CTRL	R/W	I2C_SLV4_EN	I2C_SLV4_BY TE_SW	I2C_SLV4_RE G_DIS	I2C_SLV4_DLY[4:0]				
16	22	I2C_SLV4_DO	R/W	I2C_SLV4_DO[7:0]							
17	23	I2C_SLV4_DI	R	I2C_SLV4_DI[7:0]							
7F	127	REG_BANK_SEL	R/W	-		USER_BANK[1:0]		-			

8 USER BANK 0 REGISTER DESCRIPTIONS

This section describes the function and contents of the User Bank 0 Register Map within the ICM-20948.

NOTE: The device will come up in sleep mode upon power-up.

8.1 WHO_AM_I

Name: WHO_AM_I Address: 0 (00h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0xEA		
BIT	NAME	FUNCTION
7:0	WHO_AM_I[7:0]	Register to indicate to user which device is being accessed. The value for ICM-20948 is 0xEA.

8.2 USER_CTRL

Name: USER_CTRL Address: 3 (03h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	DMP_EN	1 – Enables DMP features. 0 – DMP features are disabled after the current processing round has completed.
6	FIFO_EN	1 – Enable FIFO operation mode. 0 – Disable FIFO access from serial interface. To disable FIFO writes by DMA, use FIFO_EN register. To disable possible FIFO writes from DMP, disable the DMP.
5	I2C_MST_EN	1 – Enable the I ² C Master I/F module; pins ES_DA and ES_SCL are isolated from pins SDA/SDI and SCL/ SCLK. 0 – Disable I ² C Master I/F module; pins ES_DA and ES_SCL are logically driven by pins SDA/SDI and SCL/ SCLK.
4	I2C_IF_DIS	1 – Reset I ² C Slave module and put the serial interface in SPI mode only.
3	DMP_RST	1 – Reset DMP module. Reset is asynchronous. This bit auto clears after one clock cycle of the internal 20 MHz clock.
2	SRAM_RST	1 – Reset SRAM module. Reset is asynchronous. This bit auto clears after one clock cycle of the internal 20 MHz clock.
1	I2C_MST_RST	1 – Reset I ² C Master module. Reset is asynchronous. This bit auto clears after one clock cycle of the internal 20 MHz clock. NOTE: This bit should only be set when the I ² C master has hung. If this bit is set during an active I ² C master transaction, the I ² C slave will hang, which will require the host to reset the slave.
0	-	Reserved.

8.3 LP_CONFIG

Name: LP_CONFIG Address: 5 (05h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x40		
BIT	NAME	FUNCTION
7	-	Reserved.
6	I2C_MST_CYCLE	1 - Operate I ² C master in duty cycled mode. ODR is determined by I2C_MST_ODR_CONFIG register. 0 - Disable I ² C master duty cycled mode.
5	ACCEL_CYCLE	1 - Operate ACCEL in duty cycled mode. ODR is determined by ACCEL_SMPLRT_DIV register. 0 - Disable ACCEL duty cycled mode.
4	GYRO_CYCLE	1 - Operate GYRO in duty cycled mode. ODR is determined by GYRO_SMPLRT_DIV register. 0 - Disable GYRO duty cycled mode.
3:0	-	Reserved.

8.4 PWR_MGMT_1

Name: PWR_MGMT_1 Address: 6 (06h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x41		
BIT	NAME	FUNCTION
7	DEVICE_RESET	1 - Reset the internal registers and restores the default settings. Write a 1 to set the reset, the bit will auto clear.
6	SLEEP	When set, the chip is set to sleep mode (in sleep mode all analog is powered off). Clearing the bit wakes the chip from sleep mode.
5	LP_EN	The LP_EN only affects the digital circuitry, it helps to reduce the digital current when sensors are in LP mode. Please note that the sensors themselves are set in LP mode by the LP_CONFIG register settings. Sensors in LP mode, and use of LP_EN bit together help to reduce overall current. The bit settings are: 1: Turn on low power feature. 0: Turn off low power feature. LP_EN has no effect when the sensors are in low-noise mode.
4	-	Reserved.
3	TEMP_DIS	When set to 1, this bit disables the temperature sensor.
2:0	CLKSEL[2:0]	Code: Clock Source 0: Internal 20 MHz oscillator 1-5: Auto selects the best available clock source - PLL if ready, else use the Internal oscillator 6: Internal 20 MHz oscillator 7: Stops the clock and keeps timing generator in reset NOTE: CLKSEL[2:0] should be set to 1~5 to achieve full gyroscope performance.

8.5 PWR_MGMT_2

Name: PWR_MGMT_2 Address: 7 (07h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:3	DISABLE_ACCEL	Only the following values are applicable: 111 – Accelerometer (all axes) disabled. 000 – Accelerometer (all axes) on.
2:0	DISABLE_GYRO	Only the following values are applicable: 111 – Gyroscope (all axes) disabled. 000 – Gyroscope (all axes) on.

8.6 INT_PIN_CFG

Name: INT_PIN_CFG Address: 15 (0Fh) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	INT1_ACTL	1 – The logic level for INT1 pin is active low. 0 – The logic level for INT1 pin is active high.
6	INT1_OPEN	1 – INT1 pin is configured as open drain. 0 – INT1 pin is configured as push-pull.
5	INT1_LATCH_EN	1 – INT1 pin level held until interrupt status is cleared. 0 – INT1 pin indicates interrupt pulse is width 50 μ s.
4	INT_ANYRD_2CLEAR	1 – Interrupt status in INT_STATUS is cleared (set to 0) if any read operation is performed. 0 – Interrupt status in INT_STATUS is cleared (set to 0) only by reading INT_STATUS register. This bit only affects the interrupt status bits that are contained in the register INT_STATUS, and the corresponding hardware interrupt. This bit does not affect the interrupt status bits that are contained in registers INT_STATUS_1, INT_STATUS_2, INT_STATUS_3, and the corresponding hardware interrupt.
3	ACTL_FSYNC	1 – The logic level for the FSYNC pin as an interrupt to the ICM-20948 is active low. 0 – The logic level for the FSYNC pin as an interrupt to the ICM-20948 is active high.
2	FSYNC_INT_MODE_EN	1 – This enables the FSYNC pin to be used as an interrupt. A transition to the active level described by the ACTL_FSYNC bit will cause an interrupt. The status of the interrupt is read in the I ² C Master Status register PASS_THROUGH bit. 0 – This disables the FSYNC pin from causing an interrupt.
1	BYPASS_EN	When asserted, the I ² C_MASTER interface pins (ES_CL and ES_DA) will go into 'bypass mode' when the I ² C master interface is disabled.
0	-	Reserved.

8.7 INT_ENABLE

Name: INT_ENABLE Address: 16 (10h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	REG_WOF_EN	1 – Enable wake on FSYNC interrupt. 0 – Function is disabled.
6:4	-	Reserved.
3	WOM_INT_EN	1 – Enable interrupt for wake on motion to propagate to interrupt pin 1. 0 – Function is disabled.
2	PLL_RDY_EN	1 – Enable PLL RDY interrupt (PLL RDY means PLL is running and in use as the clock source for the system) to propagate to interrupt pin 1. 0 – Function is disabled.
1	DMP_INT1_EN	1 – Enable DMP interrupt to propagate to interrupt pin 1. 0 – Function is disabled.
0	I2C_MST_INT_EN	1 – Enable I ² C master interrupt to propagate to interrupt pin 1. 0 – Function is disabled.

8.8 INT_ENABLE_1

Name: INT_ENABLE_1 Address: 17 (11h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:1	-	Reserved.
0	RAW_DATA_0_RDY_EN	1 – Enable raw data ready interrupt from any sensor to propagate to interrupt pin 1. 0 – Function is disabled.

8.9 INT_ENABLE_2

Name: INT_ENABLE_2 Address: 18 (12h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_OVERFLOW_EN[4:0]	1 – Enable interrupt for FIFO overflow to propagate to interrupt pin 1. 0 – Function is disabled.

8.10 INT_ENABLE_3

Name: INT_ENABLE_3 Address: 19 (13h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_WM_EN[4:0]	1 – Enable interrupt for FIFO watermark to propagate to interrupt pin 1. 0 – Function is disabled.

8.11 I2C_MST_STATUS

Name: I2C_MST_STATUS Address: 23 (17h) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7	PASS_THROUGH	Status of FSYNC interrupt – used as a way to pass an external interrupt through this chip to the host. If enabled in the INT_PIN_CFG register by asserting bit FSYNC_INT_MODE_EN, this will cause an interrupt. A read of this register clears all status bits in this register.
6	I2C_SLV4_DONE	Asserted when I ² C slave 4's transfer is complete, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted, and if the SLV4_DONE_INT_EN bit is asserted in the I2C_SLV4_CTRL register.
5	I2C_LOST_ARB	Asserted when I ² C slave loses arbitration of the I ² C bus, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.
4	I2C_SLV4_NACK	Asserted when slave 4 receives a NACK, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.
3	I2C_SLV3_NACK	Asserted when slave 3 receives a NACK, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.
2	I2C_SLV2_NACK	Asserted when slave 2 receives a NACK, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.
1	I2C_SLV1_NACK	Asserted when slave 1 receives a NACK, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.
0	I2C_SLV0_NACK	Asserted when slave 0 receives a NACK, will cause an interrupt if bit I2C_MST_INT_EN in the INT_ENABLE register is asserted.

8.12 INT_STATUS

Name: INT_STATUS Address: 25 (19h) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7:4	-	Reserved.
3	WOM_INT	1 – Wake on motion interrupt occurred.
2	PLL_RDY_INT	1 – Indicates that the PLL has been enabled and is ready (delay of 4 ms ensures lock).
1	DMP_INT1	1 – Indicates the DMP has generated INT1 interrupt.
0	I2C_MST_INT	1 – Indicates I ² C master has generated an interrupt.

8.13 INT_STATUS_1

Name: INT_STATUS_1 Address: 26 (1Ah) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7:1	-	Reserved.
0	RAW_DATA_0_RDY_INT	1 – Sensor Register Raw Data, from all sensors, is updated and ready to be read.

8.14 INT_STATUS_2

Name: INT_STATUS_2 Address: 27 (1Bh) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_OVERFLOW_INT[4:0]	1 – FIFO Overflow interrupt occurred.

8.15 INT_STATUS_3

Name: INT_STATUS_3 Address: 28 (1Ch) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_WM_INT[4:0]	1 – Watermark interrupt for FIFO occurred.

8.16 DELAY_TIMEH

Name: DELAY_TIMEH Address: 40 (28h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	DELAY_TIMEH[7:0]	High-byte of delay time between FSYNC event and the 1st gyro ODR event (after the FSYNC event). Reading DELAY_TIMEH will lock DELAY_TIMEH and DELAY_TIMEL from the next update. Reading DELAY_TIMEL will unlock DELAY_TIMEH and DELAY_TIMEL to take the next update due to an FSYNC event.

8.17 DELAY_TIMEL

Name: DELAY_TIMEL Address: 41 (29h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	DELAY_TIMEL[7:0]	Low-byte of delay time between FSYNC event and the 1st gyro ODR event (after the FSYNC event). Reading DELAY_TIMEH will lock DELAY_TIMEH and DELAY_TIMEL from the next update. Reading DELAY_TIMEL will unlock DELAY_TIMEH and DELAY_TIMEL to take the next update due to an FSYNC event. Delay time in $\mu s = (DELAY_TIMEH * 256 + DELAY_TIMEL) * 0.9645$

8.18 ACCEL_XOUT_H

Name: ACCEL_XOUT_H Address: 45 (2Dh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_XOUT_H[7:0]	High Byte of Accelerometer X-axis data.

8.19 ACCEL_XOUT_L

Name: ACCEL_XOUT_L Address: 46 (2Eh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_XOUT_L[7:0]	Low Byte of Accelerometer X-axis data. To convert the output of the accelerometer to acceleration measurement use the formula below: $X_acceleration = ACCEL_XOUT / Accel_Sensitivity$

8.20 ACCEL_YOUT_H

Name: ACCEL_YOUT_H Address: 47 (2Fh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_YOUT_H[7:0]	High Byte of Accelerometer Y-axis data.

8.21 ACCEL_YOUT_L

Name: ACCEL_YOUT_L Address: 48 (30h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_YOUT_L[7:0]	Low Byte of Accelerometer Y-axis data. To convert the output of the accelerometer to acceleration measurement use the formula below: $Y_acceleration = ACCEL_YOUT / Accel_Sensitivity$

8.22 ACCEL_ZOUT_H

Name: ACCEL_ZOUT_H Address: 49 (31h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_ZOUT_H[7:0]	High Byte of Accelerometer Z-axis data.

8.23 ACCEL_ZOUT_L

Name: ACCEL_ZOUT_L Address: 50 (32h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_ZOUT_L[7:0]	Low Byte of Accelerometer Z-axis data. To convert the output of the accelerometer to acceleration measurement use the formula below: $Z_acceleration = ACCEL_ZOUT / Accel_Sensitivity$

8.24 GYRO_XOUT_H

Name: GYRO_XOUT_H Address: 51 (33h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_XOUT_H[7:0]	High Byte of Gyroscope X-axis data.

8.25 GYRO_XOUT_L

Name: GYRO_XOUT_L Address: 52 (34h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_XOUT_L[7:0]	Low Byte of Gyroscope X-axis data. To convert the output of the gyroscope to angular rate measurement use the formula below: $X_angular_rate = GYRO_XOUT / Gyro_Sensitivity$

8.26 GYRO_YOUT_H

Name: GYRO_YOUT_H Address: 53 (35h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_YOUT_H[7:0]	High Byte of Gyroscope Y-axis data.

8.27 GYRO_YOUT_L

Name: GYRO_YOUT_L Address: 54 (36h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_YOUT_L[7:0]	Low Byte of Gyroscope Y-axis data. To convert the output of the gyroscope to angular rate measurement use the formula below: $Y_angular_rate = GYRO_YOUT / Gyro_Sensitivity$

8.28 GYRO_ZOUT_H

Name: GYRO_ZOUT_H Address: 55 (37h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_ZOUT_H[7:0]	High Byte of Gyroscope Z-axis data.

8.29 GYRO_ZOUT_L

Name: GYRO_ZOUT_L Address: 56 (38h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_ZOUT_L[7:0]	Low Byte of Gyroscope Z-axis data. To convert the output of the gyroscope to angular rate measurement use the formula below: $Z_angular_rate = GYRO_ZOUT / Gyro_Sensitivity$

8.30 TEMP_OUT_H

Name: TEMP_OUT_H Address: 57 (39h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	TEMP_OUT_H[7:0]	High Byte of Temp sensor data.

8.31 TEMP_OUT_L

Name: TEMP_OUT_L Address: 58 (3Ah) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	TEMP_OUT_L[7:0]	Low Byte of Temp sensor data. To convert the output of the temperature sensor to degrees C use the following formula: $TEMP_degC = ((TEMP_OUT - RoomTemp_Offset) / Temp_Sensitivity) + 21degC$

8.32 EXT_SLV_SENS_DATA_00

Name: EXT_SLV_SENS_DATA_00 Address: 59 (3Bh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_00[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.33 EXT_SLV_SENS_DATA_01

Name: EXT_SLV_SENS_DATA_01 Address: 60 (3Ch) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_01[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.34 EXT_SLV_SENS_DATA_02

Name: EXT_SLV_SENS_DATA_02 Address: 61 (3Dh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_02[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.35 EXT_SLV_SENS_DATA_03

Name: EXT_SLV_SENS_DATA_03 Address: 62 (3Eh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_03[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.36 EXT_SLV_SENS_DATA_04

Name: EXT_SLV_SENS_DATA_04 Address: 63 (3Fh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_04[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.37 EXT_SLV_SENS_DATA_05

Name: EXT_SLV_SENS_DATA_05 Address: 64 (40h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_05[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.38 EXT_SLV_SENS_DATA_06

Name: EXT_SLV_SENS_DATA_06 Address: 65 (41h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_06[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.39 EXT_SLV_SENS_DATA_07

Name: EXT_SLV_SENS_DATA_07 Address: 66 (42h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_07[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.40 EXT_SLV_SENS_DATA_08

Name: EXT_SLV_SENS_DATA_08 Address: 67 (43h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_08[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.41 EXT_SLV_SENS_DATA_09

Name: EXT_SLV_SENS_DATA_09 Address: 68 (44h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_09[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.42 EXT_SLV_SENS_DATA_10

Name: EXT_SLV_SENS_DATA_10 Address: 69 (45h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_10[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.43 EXT_SLV_SENS_DATA_11

Name: EXT_SLV_SENS_DATA_11 Address: 70 (46h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_11[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.44 EXT_SLV_SENS_DATA_12

Name: EXT_SLV_SENS_DATA_12 Address: 71 (47h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_12[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.45 EXT_SLV_SENS_DATA_13

Name: EXT_SLV_SENS_DATA_13 Address: 72 (48h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_13[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.46 EXT_SLV_SENS_DATA_14

Name: EXT_SLV_SENS_DATA_14 Address: 73 (49h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_14[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.47 EXT_SLV_SENS_DATA_15

Name: EXT_SLV_SENS_DATA_15 Address: 74 (4Ah) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_15[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.48 EXT_SLV_SENS_DATA_16

Name: EXT_SLV_SENS_DATA_16 Address: 75 (4Bh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_16[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.49 EXT_SLV_SENS_DATA_17

Name: EXT_SLV_SENS_DATA_17 Address: 76 (4Ch) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_17[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.50 EXT_SLV_SENS_DATA_18

Name: EXT_SLV_SENS_DATA_18 Address: 77 (4Dh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_18[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.51 EXT_SLV_SENS_DATA_19

Name: EXT_SLV_SENS_DATA_19 Address: 78 (4Eh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_19[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.52 EXT_SLV_SENS_DATA_20

Name: EXT_SLV_SENS_DATA_20 Address: 79 (4Fh) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_20[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.53 EXT_SLV_SENS_DATA_21

Name: EXT_SLV_SENS_DATA_21 Address: 80 (50h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_21[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.54 EXT_SLV_SENS_DATA_22

Name: EXT_SLV_SENS_DATA_22 Address: 81 (51h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_22[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.55 EXT_SLV_SENS_DATA_23

Name: EXT_SLV_SENS_DATA_23 Address: 82 (52h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	EXT_SLV_SENS_DATA_23[7:0]	Sensor data read from external I ² C devices via the I ² C master interface. The data stored is controlled by the I2C_SLV(0-4)_ADDR, I2C_SLV(0-4)_REG, and I2C_SLV(0-4)_CTRL registers.

8.56 FIFO_EN_1

Name: FIFO_EN_1 Address: 102 (66h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:4	-	Reserved.
3	SLV_3_FIFO_EN	1 – Write EXT_SENS_DATA registers associated to SLV_3 (as determined by I2C_SLV2_CTRL, I2C_SLV1_CTRL, and I2C_SL20_CTRL) to the FIFO at the sample rate; 0 – Function is disabled.
2	SLV_2_FIFO_EN	1 – Write EXT_SENS_DATA registers associated to SLV_2 (as determined by I2C_SLV0_CTRL, I2C_SLV1_CTRL, and I2C_SL20_CTRL) to the FIFO at the sample rate; 0 – Function is disabled.
1	SLV_1_FIFO_EN	1 – Write EXT_SENS_DATA registers associated to SLV_1 (as determined by I2C_SLV0_CTRL and I2C_SLV1_CTRL) to the FIFO at the sample rate; 0 – Function is disabled.
0	SLV_0_FIFO_EN	1 – Write EXT_SENS_DATA registers associated to SLV_0 (as determined by I2C_SLV0_CTRL) to the FIFO at the sample rate; 0 – Function is disabled.

8.57 FIFO_EN_2

Name: FIFO_EN_2 Address: 103 (67h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4	ACCEL_FIFO_EN	1 – Write ACCEL_XOUT_H, ACCEL_XOUT_L, ACCEL_YOUT_H, ACCEL_YOUT_L, ACCEL_ZOUT_H, and ACCEL_ZOUT_L to the FIFO at the sample rate; 0 – Function is disabled.
3	GYRO_Z_FIFO_EN	1 – Write GYRO_ZOUT_H and GYRO_ZOUT_L to the FIFO at the sample rate. 0 – Function is disabled.
2	GYRO_Y_FIFO_EN	1 – Write GYRO_YOUT_H and GYRO_YOUT_L to the FIFO at the sample rate. 0 – Function is disabled.
1	GYRO_X_FIFO_EN	1 – Write GYRO_XOUT_H and GYRO_XOUT_L to the FIFO at the sample rate. 0 – Function is disabled.
0	TEMP_FIFO_EN	1 – Write TEMP_OUT_H and TEMP_OUT_L to the FIFO at the sample rate. 0 – Function is disabled.

8.58 FIFO_RST

Name: FIFO_RST Address: 104 (68h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_RESET[4:0]	S/W FIFO reset. Assert and hold to set FIFO size to 0. Assert and de-assert to reset FIFO.

8.59 FIFO_MODE

Name: FIFO_MODE Address: 105 (69h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_MODE[4:0]	0 – Stream. 1 – Snapshot. When set to '1', when the FIFO is full, additional writes will not be written to FIFO. When set to '0', when the FIFO is full, additional writes will be written to the FIFO, replacing the oldest data.

8.60 FIFO_COUNTH

Name: FIFO_COUNTH Address: 112 (70h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4:0	FIFO_CNT[12:8]	High Bits, count indicates the number of written bytes in the FIFO. Reading this byte latches the data for both FIFO_COUNTH, and FIFO_COUNTL.

8.61 FIFO_COUNTL

Name: FIFO_COUNTL Address: 113 (71h) Type: USR0 Bank: 0 Serial IF: R Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	FIFO_CNT[7:0]	Low bits, count indicates the number of written bytes in the FIFO.

8.62 FIFO_R_W

Name: FIFO_R_W Address: 114 (72h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	FIFO_R_W[7:0]	Reading from or writing to this register actually reads/writes the FIFO. For example, to write a byte to the FIFO, write the desired byte value to FIFO_R_W[7:0]. To read a byte from the FIFO, perform a register read operation and access the result in FIFO_R_W[7:0].

8.63 DATA_RDY_STATUS

Name: DATA_RDY_STATUS Address: 116 (74h) Type: USR0 Bank: 0 Serial IF: R/C Reset Value: 0x00		
BIT	NAME	FUNCTION
7	WOF_STATUS	Wake on FSYNC interrupt status. Cleared on read.
6:4	-	Reserved.
3:0	RAW_DATA_RDY[3:0]	Data from sensors is copied to FIFO or SRAM. Set when sequence controller kicks off on a sensor data load. Only bit 0 is relevant in a single FIFO configuration. Cleared on read.

8.64 FIFO_CFG

Name: FIFO_CFG Address: 118 (76h) Type: USR0 Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:1	-	Reserved.
0	FIFO_CFG	This bit should be set to 1 if interrupt status for each sensor is required.

8.65 REG_BANK_SEL

Name: REG_BANK_SEL Address: 127 (7Fh) Type: ALL Bank: 0 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:4	USER_BANK[1:0]	Use the following values in this bit-field to select a USER BANK. 0: Select USER BANK 0. 1: Select USER BANK 1. 2: Select USER BANK 2. 3: Select USER BANK 3.
3:0	-	Reserved.

9 USR BANK 1 REGISTER DESCRIPTIONS

This section describes the function and contents of the User Bank 1 Register Map within the ICM-20948.

NOTE: The device will come up in sleep mode upon power-up.

9.1 SELF_TEST_X_GYRO

Name: SELF_TEST_X_GYRO Address: 2 (02h) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	XG_ST_DATA[7:0]	The value in this register indicates the self-test output generated during manufacturing tests. This value is to be used to check against subsequent self-test outputs performed by the end user.

9.2 SELF_TEST_Y_GYRO

Name: SELF_TEST_Y_GYRO Address: 3 (03h) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	YG_ST_DATA[7:0]	The value in this register indicates the self-test output generated during manufacturing tests. This value is to be used to check against subsequent self-test outputs performed by the end user.

9.3 SELF_TEST_Z_GYRO

Name: SELF_TEST_Z_GYRO Address: 4 (04h) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ZG_ST_DATA[7:0]	The value in this register indicates the self-test output generated during manufacturing tests. This value is to be used to check against subsequent self-test outputs performed by the end user.

9.4 SELF_TEST_X_ACCEL

Name: SELF_TEST_X_ACCEL Address: 14 (0Eh) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	XA_ST_DATA[7:0]	Contains self-test data for the X Accelerometer.

9.5 SELF_TEST_Y_ACCEL

Name: SELF_TEST_Y_ACCEL

Address: 15 (0Fh)

Type: USR1

Bank: 1

Serial IF: R/W

Reset Value: 0x00

BIT	NAME	FUNCTION
7:0	YA_ST_DATA[7:0]	Contains self-test data for the Y Accelerometer.

9.6 SELF_TEST_Z_ACCEL

Name: SELF_TEST_Z_ACCEL

Address: 16 (10h)

Type: USR1

Bank: 1

Serial IF: R/W

Reset Value: 0x00

BIT	NAME	FUNCTION
7:0	ZA_ST_DATA[7:0]	Contains self-test data for the Z Accelerometer.

9.7 XA_OFFS_H

Name: XA_OFFS_H

Address: 20 (14h)

Type: USR1

Bank: 1

Serial IF: R/W

Reset Value: Trimmed on a per-part basis for optimal performance

BIT	NAME	FUNCTION
7:0	XA_OFFS[14:7]	Upper bits of the X accelerometer offset cancellation.

9.8 XA_OFFS_L

Name: XA_OFFS_L

Address: 21 (15h)

Type: USR1

Bank: 1

Serial IF: R/W

Reset Value: Trimmed on a per-part basis for optimal performance

BIT	NAME	FUNCTION
7:1	XA_OFFS[6:0]	Lower bits of the X accelerometer offset cancellation.
0	-	Reserved.

9.9 YA_OFFS_H

Name: YA_OFFS_H

Address: 23 (17h)

Type: USR1

Bank: 1

Serial IF: R/W

Reset Value: Trimmed on a per-part basis for optimal performance

BIT	NAME	FUNCTION
7:0	YA_OFFS[14:7]	Upper bits of the Y accelerometer offset cancellation.

9.10 YA_OFFS_L

Name: YA_OFFS_L Address: 24 (18h) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: Trimmed on a per-part basis for optimal performance		
BIT	NAME	FUNCTION
7:1	YA_OFFS[6:0]	Lower bits of the Y accelerometer offset cancellation.
0	-	Reserved .

9.11 ZA_OFFS_H

Name: ZA_OFFS_H Address: 26 (1Ah) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: Trimmed on a per-part basis for optimal performance		
BIT	NAME	FUNCTION
7:0	ZA_OFFS[14:7]	Upper bits of the Z accelerometer offset cancellation.

9.12 ZA_OFFS_L

Name: ZA_OFFS_L Address: 27 (1Bh) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: Trimmed on a per-part basis for optimal performance		
BIT	NAME	FUNCTION
7:1	ZA_OFFS[6:0]	Lower bits of the Z accelerometer offset cancellation.
0	-	Reserved.

9.13 TIMEBASE_CORRECTION_PLL

Name: TIMEBASE_CORRECTION_PLL Address: 40 (28h) Type: USR1 Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	TBC_PLL[7:0]	System PLL clock period error (signed, [-10%, +10%]).

9.14 REG_BANK_SEL

Name: REG_BANK_SEL Address: 127 (7Fh) Type: Bank: 1 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:4	USER_BANK[1:0]	Use the following values in this bit-field to select a USER BANK. 0: Select USER BANK 0. 1: Select USER BANK 1. 2: Select USER BANK 2. 3: Select USER BANK 3.
3:0	-	Reserved.

10 USR BANK 2 REGISTER MAP

This section describes the function and contents of the User Bank 2 Register Map within the ICM-20948.

NOTE: The device will come up in sleep mode upon power-up.

10.1 GYRO_SMPLRT_DIV

Name: GYRO_SMPLRT_DIV Address: 0 (00h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	GYRO_SMPLRT_DIV[7:0]	Gyro sample rate divider. Divides the internal sample rate to generate the sample rate that controls sensor data output rate, FIFO sample rate, and DMP sequence rate. NOTE: This register is only effective when FCHOICE = 1'b1 (FCHOICE_B register bit is 1'b0), and (0 < DLPF_CFG < 7). ODR is computed as follows: $1.1 \text{ kHz} / (1 + \text{GYRO_SMPLRT_DIV}[7:0])$

10.2 GYRO_CONFIG_1

Name: GYRO_CONFIG_1 Address: 1 (01h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x01		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:3	GYRO_DLPFCFG[2:0]	Gyro low pass filter configuration as shown in Table 16.
2:1	GYRO_FS_SEL[1:0]	Gyro Full Scale Select: 00 = ±250 dps 01 = ±500 dps 10 = ±1000 dps 11 = ±2000 dps
0	GYRO_FCHOICE	0 – Bypass gyro DLPF. 1 – Enable gyro DLPF.

The gyroscope DLPF is configured by GYRO_DLPFCFG, when GYRO_FCHOICE = 1. The gyroscope data is filtered according to the value of GYRO_DLPFCFG and GYRO_FCHOICE as shown in Table 16.

GYRO_FCHOICE	GYRO_DLPFCFG	OUTPUT		
		3DB BW [Hz]	NBW [Hz]	RATE [Hz]
0	x	12106	12316	9000
1	0	196.6	229.8	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	1	151.8	187.6	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	2	119.5	154.3	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	3	51.2	73.3	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	4	23.9	35.9	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	5	11.6	17.8	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	6	5.7	8.9	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255
1	7	361.4	376.5	1125/(1+GYRO_SMPLRT_DIV)Hz where GYRO_SMPLRT_DIV is 0, 1, 2,...255

Table 16. Gyroscope Configuration 1

10.3 GYRO_CONFIG_2

Name: GYRO_CONFIG_2 Address: 2 (02h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5	XGYRO_CTEN	X Gyro self-test enable.
4	YGYRO_CTEN	Y Gyro self-test enable.
3	ZGYRO_CTEN	Z Gyro self-test enable.
2:0	GYRO_AVGCFG[2:0]	Averaging filter configuration settings for low-power mode. 0: 1x averaging. 1: 2x averaging. 2: 4x averaging. 3: 8x averaging. 4: 16x averaging. 5: 32x averaging. 6: 64x averaging. 7: 128x averaging.

Table 17 lists the gyroscope filter bandwidths available in the low-power mode of operation. In the low-power mode of operation, the gyroscope is duty-cycled.

	AVERAGES	1X	2X	4X	8X	16X	32X	64X	128X
	GYRO_FCHOICE	1	1	1	1	1	1	1	1
	GYRO_AVGCFG	0	1	2	3	4	5	6	7
	TON [MS]	1.15	1.59	2.48	4.26	7.82	14.93	29.15	57.59
	NBW [HZ]	773.5	469.8	257.8	134.8	68.9	34.8	17.5	8.8
	RMS NOISE [DPS-RMS] TYP (BASED ON GYROSCOPE NOISE: 0.011 DPS/√HZ)	0.31	0.24	0.18	0.13	0.09	0.06	0.05	0.03
GYRO_SMPLRT_DIV	ODR [HZ]	CURRENT CONSUMPTION [mA] TYP							
255	4.4	1.04	1.05	1.05	1.06	1.09	1.14	1.24	1.45
64	17.3	1.07	1.08	1.10	1.15	1.25	1.45	1.85	N/A
63	17.6	1.07	1.08	1.11	1.16	1.26	1.46	1.87	
32	34.1	1.10	1.12	1.17	1.27	1.47	1.86	N/A	
31	35.2	1.10	1.13	1.18	1.28	1.48	1.89		
22	48.9	1.13	1.16	1.23	1.37	1.66	2.22		
16	66.2	1.16	1.21	1.30	1.49	1.88			
15	70.3	1.17	1.22	1.32	1.52	1.93	N/A		
10	102.3	1.23	1.30	1.45	1.74	2.34			
8	125.0	1.27	1.36	1.54	1.90				
7	140.6	1.30	1.40	1.60	2.01	N/A			
5	187.5	1.38	1.52	1.79	2.33				
4	225.0	1.45	1.62	1.94					
3	281.3	1.56	1.76	2.17	N/A				
2	375.0	1.74	2.00						
1	562.5	2.09	N/A						

Table 17. Gyroscope Configuration 2

NOTE: Ton is the ON time for motion measurement when the gyroscope is in duty cycle mode.

10.4 XG_OFFS_USRH

Name: XG_OFFS_USRH Address: 3 (03h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	X_OFFS_USER[15:8]	Upper byte of X gyro offset cancellation.

10.5 XG_OFFS_USRL

Name: XG_OFFS_USRL Address: 4 (04h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	X_OFFS_USER[7:0]	Lower byte of X gyro offset cancellation.

10.6 YG_OFFS_USRH

Name: YG_OFFS_USRH Address: 5 (05h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	Y_OFFS_USER[15:8]	Upper byte of Y gyro offset cancellation.

10.7 YG_OFFS_USRL

Name: YG_OFFS_USRL Address: 6 (06h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	Y_OFFS_USER[7:0]	Lower byte of Y gyro offset cancellation.

10.8 ZG_OFFS_USRH

Name: ZG_OFFS_USRH Address: 7 (07h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	Z_OFFS_USER[15:8]	Upper byte of Z gyro offset cancellation.

10.9 ZG_OFFS_USRL

Name: ZG_OFFS_USRL Address: 8 (08h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	Z_OFFS_USER[7:0]	Lower byte of Z gyro offset cancellation.

10.10 ODR_ALIGN_EN

Name: ODR_ALIGN_EN Address: 9 (09h) Type: USR2 Bank: 2 OTP: No Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:1	-	Reserved.
0	ODR_ALIGN_EN	0: Disables ODR start-time alignment. 1: Enables ODR start-time alignment when any of the following registers is written (with the same value or with different values): GYRO_SMPLRT_DIV, ACCEL_SMPLRT_DIV_1, ACCEL_SMPLRT_DIV_2, I2C_MST_ODR_CONFIG.

10.11 ACCEL_SMPLRT_DIV_1

Name: ACCEL_SMPLRT_DIV_1 Address: 16 (10h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:4	-	Reserved.
3:0	ACCEL_SMPLRT_DIV[11:8]	MSB for ACCEL sample rate div.

10.12 ACCEL_SMPLRT_DIV_2

Name: ACCEL_SMPLRT_DIV_2 Address: 17 (11h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	ACCEL_SMPLRT_DIV[7:0]	LSB for ACCEL sample rate div. ODR is computed as follows: $1.125 \text{ kHz} / (1 + \text{ACCEL_SMPLRT_DIV}[11:0])$

10.13 ACCEL_INTEL_CTRL

Name: ACCEL_INTEL_CTRL Address: 18 (12h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:2	-	Reserved.
1	ACCEL_INTEL_EN	Enable the WOM logic.
0	ACCEL_INTEL_MODE_INT	Selects WOM algorithm. 1 = Compare the current sample with the previous sample. 0 = Initial sample is stored, all future samples are compared to the initial sample.

10.14 ACCEL_WOM_THR

Name: ACCEL_WOM_THR Address: 19 (13h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	WOM_THRESHOLD[7:0]	This register holds the threshold value for the Wake on Motion Interrupt for ACCEL x/y/z axes. LSB = 4 mg. Range is 0 mg to 1020 mg.

10.15 ACCEL_CONFIG

Name: ACCEL_CONFIG Address: 20 (14h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x01		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:3	ACCEL_DLPFCFG[2:0]	Accelerometer low pass filter configuration as shown in Table 18.
2:1	ACCEL_FS_SEL[1:0]	Accelerometer Full Scale Select: 00: ±2g 01: ±4g 10: ±8g 11: ±16g
0	ACCEL_FCHOICE	0: Bypass accel DLPF. 1: Enable accel DLPF.

ACCEL_FCHOICE	ACCEL_DLPFCFG	OUTPUT		
		3DB BW [HZ]	NBW [HZ]	RATE [HZ]
0	x	1209	1248	4500
1	0	246.0	265.0	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	1	246.0	265.0	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	2	111.4	136.0	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	3	50.4	68.8	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	4	23.9	34.4	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	5	11.5	17.0	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	6	5.7	8.3	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095
1	7	473	499	1125/(1+ACCEL_SMPLRT_DIV)Hz where ACCEL_SMPLRT_DIV is 0, 1, 2,...4095

Table 18. Accelerator Configuration

The data rate out of the DLPF filter block can be further reduced by a factor of $1.125 \text{ kHz}/(1+\text{ACCEL_SMPLRT_DIV}[11:0])$ where ACCEL_SMPLRT_DIV is a 12-bit integer.

10.16 ACCEL_CONFIG_2

Name: ACCEL_CONFIG_2 Address: 21 (15h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:5	-	Reserved.
4	AX_ST_EN_REG	X Accel self-test enable.
3	AY_ST_EN_REG	Y Accel self-test enable.
2	AZ_ST_EN_REG	Z Accel self-test enable.
1:0	DEC3_CFG[1:0]	Controls the number of samples averaged in the accelerometer decimator: 0: Average 1 or 4 samples depending on ACCEL_FCHOICE (see Table 19). 1: Average 8 samples. 2: Average 16 samples. 3: Average 32 samples.

Table 19 lists the accelerometer filter bandwidths available in the low-power mode of operation. In the low-power mode of operation, the accelerometer is duty-cycled.

	AVERAGES	1X	4X	8X	16X	32X
	ACCEL_FCHOICE	0	1	1	1	1
	ACCEL_DLPFCFG	x	7	7	7	7
	DEC3_CFG	0	0	1	2	3
	TON (MS)	0.821	1.488	2.377	4.154	7.71
	NBW (HZ)	1237.5	496.8	264.8	136.5	69.2
	RMS NOISE [MG-RMS] TYP (BASED ON ACCELEROMETER NOISE: 190µG/√HZ)	6.7	4.2	3.1	2.2	1.6
ACCEL_SmplRT_DIV	ODR [HZ]	CURRENT CONSUMPTION [µA] TYP				
4095	0.27	6.2	6.3	6.5	6.9	7.6
2044	0.55	6.3	6.6	7.0	7.7	9.2
1022	1.1	6.7	7.2	8.0	9.4	12.3
513	2.2	7.3	8.4	9.9	12.8	18.6
255	4.4	8.7	10.9	13.8	19.7	31.4
127	8.8	11.4	15.8	21.6	33.3	56.7
63	17.6	16.8	25.6	37.3	60.7	107.5
31	35.2	27.6	45.2	68.6	115.3	208.9
22	48.9	36.1	60.5	93.0	158.1	288.3
15	70.3	49.2	84.3	131.1	224.7	411.9
10	102.3	68.9	119.9	188.0	324.1	596.3
7	140.6	92.4	162.7	256.3	443.3	N/A

5	187.5	121.2	214.9	
3	281.3	178.9	319.3	N/A
1	562.5	351.7		N/A

Table 19. Accelerator Configuration 2

NOTE: Ton is the ON time for motion measurement when the accelerometer is in duty cycle mode.

10.17 FSYNC_CONFIG

Name: FSYNC_CONFIG Address: 82 (52h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	DELAY_TIME_EN	0: Disables delay time measurement between FSYNC event and the first ODR event (after FSYNC event). 1: Enables delay time measurement between FSYNC event and the first ODR event (after FSYNC event).
6	-	Reserved.
5	WOF_DEGLITCH_EN	Enable digital deglitching of FSYNC input for Wake on FSYNC.
4	WOF_EDGE_INT	0: FSYNC is a level interrupt for Wake on FSYNC. 1: FSYNC is an edge interrupt for Wake on FSYNC. ACTL_FSYNC is used to set the polarity of the interrupt.
3:0	EXT_SYNC_SET[3:0]	Enables the FSYNC pin data to be sampled. EXT_SYNC_SET FSYNC bit location. 0: Function disabled. 1: TEMP_OUT_L[0]. 2: GYRO_XOUT_L[0]. 3: GYRO_YOUT_L[0]. 4: GYRO_ZOUT_L[0]. 5: ACCEL_XOUT_L[0]. 6: ACCEL_YOUT_L[0]. 7: ACCEL_ZOUT_L[0].

10.18 TEMP_CONFIG

Name: TEMP_CONFIG Address: 83 (53h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00																															
BIT	NAME	FUNCTION																													
2:0	TEMP_DLPCFG[2:0]	Low pass filter configuration for temperature sensor as shown in the table below: <table border="1"> <thead> <tr> <th rowspan="2">TEMP_DLPCFG<2:0></th><th colspan="2">TEMP SENSOR</th></tr> <tr> <th>NBW (HZ)</th><th>RATE (KHZ)</th></tr> </thead> <tbody> <tr><td>0</td><td>7932.0</td><td>9</td></tr> <tr><td>1</td><td>217.9</td><td>1.125</td></tr> <tr><td>2</td><td>123.5</td><td>1.125</td></tr> <tr><td>3</td><td>65.9</td><td>1.125</td></tr> <tr><td>4</td><td>34.1</td><td>1.125</td></tr> <tr><td>5</td><td>17.3</td><td>1.125</td></tr> <tr><td>6</td><td>8.8</td><td>Rate (kHz)</td></tr> <tr><td>7</td><td>7932.0</td><td>9</td></tr> </tbody> </table>	TEMP_DLPCFG<2:0>	TEMP SENSOR		NBW (HZ)	RATE (KHZ)	0	7932.0	9	1	217.9	1.125	2	123.5	1.125	3	65.9	1.125	4	34.1	1.125	5	17.3	1.125	6	8.8	Rate (kHz)	7	7932.0	9
TEMP_DLPCFG<2:0>	TEMP SENSOR																														
	NBW (HZ)	RATE (KHZ)																													
0	7932.0	9																													
1	217.9	1.125																													
2	123.5	1.125																													
3	65.9	1.125																													
4	34.1	1.125																													
5	17.3	1.125																													
6	8.8	Rate (kHz)																													
7	7932.0	9																													

10.19 MOD_CTRL_USR

Name: MOD_CTRL_USR Address: 84 (54h) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x03		
BIT	NAME	FUNCTION
7:1	-	Reserved.
0	REG_LP_DMP_EN	Enable turning on DMP in Low Power Accelerometer mode.

10.20 REG_BANK_SEL

Name: REG_BANK_SEL Address: 127 (7Fh) Type: USR2 Bank: 2 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:6	-	Reserved.
5:4	USER_BANK[1:0]	Use the following values in this bit-field to select a USER BANK. 0: Select USER BANK 0. 1: Select USER BANK 1. 2: Select USER BANK 2. 3: Select USER BANK 3.
3:0	-	Reserved.

11 USR BANK 3 REGISTER MAP

This section describes the function and contents of the User Bank 3 Register Map within the ICM-20948.

NOTE: The device will come up in sleep mode upon power-up.

11.1 I2C_MST_ODR_CONFIG

Name: I2C_MST_ODR_CONFIG Address: 0 (00h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:4	-	Reserved
3:0	I2C_MST_ODR_CONFIG[3:0]	ODR configuration for external sensor when gyroscope and accelerometer are disabled. ODR is computed as follows: $1.1 \text{ kHz} / (2^{((\text{odr_config}[3:0]))})$ When gyroscope is enabled, all sensors (including I2C_MASTER) use the gyroscope ODR. If gyroscope is disabled, then all sensors (including I2C_MASTER) use the accelerometer ODR.

11.2 I2C_MST_CTRL

Name: I2C_MST_CTRL Address: 1 (01h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	MULT_MST_EN	Enables multi-master capability. When disabled, clocking to the I2C_MST_IF can be disabled when not in use and the logic to detect lost arbitration is disabled.
6:5	-	Reserved.
4	I2C_MST_P_NSR	This bit controls the I ² C Master's transition from one slave read to the next slave read. 0 - There is a restart between reads. 1 - There is a stop between reads.
3:0	I2C_MST_CLK[3:0]	Sets I ² C master clock frequency as shown in Table 23.

11.3 I2C_MST_DELAY_CTRL

Name: I2C_MST_DELAY_CTRL Address: 2 (02h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	DELAY_ES_SHADOW	Delays shadowing of external sensor data until all data is received.
6:5	-	Reserved.
4	I2C_SLV4_DELAY_EN	When enabled, slave 4 will only be accessed 1/(1+I2C_SLC4_DLY) samples as determined by I2C_MST_ODR_CONFIG.
3	I2C_SLV3_DELAY_EN	When enabled, slave 3 will only be accessed 1/(1+I2C_SLC4_DLY) samples as determined by I2C_MST_ODR_CONFIG.
2	I2C_SLV2_DELAY_EN	When enabled, slave 2 will only be accessed 1/(1+I2C_SLC4_DLY) samples as determined by I2C_MST_ODR_CONFIG.
1	I2C_SLV1_DELAY_EN	When enabled, slave 1 will only be accessed 1/(1+I2C_SLC4_DLY) samples as determined by I2C_MST_ODR_CONFIG.
0	I2C_SLV0_DELAY_EN	When enabled, slave 0 will only be accessed 1/(1+I2C_SLC4_DLY) samples as determined by I2C_MST_ODR_CONFIG.

11.4 I2C_SLV0_ADDR

Name: I2C_SLV0_ADDR Address: 3 (03h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV0_RNW	1 – Transfer is a read. 0 – Transfer is a write.
6:0	I2C_ID_0[6:0]	Physical address of I ² C slave 0.

11.5 I2C_SLV0_REG

Name: I2C_SLV0_REG Address: 4 (04h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV0_REG[7:0]	I ² C slave 0 register address from where to begin data transfer.

11.6 I2C_SLV0_CTRL

Name: I2C_SLV0_CTRL Address: 5 (05h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV0_EN	1 – Enable reading data from this slave at the sample rate and storing data at the first available EXT_SENS_DATA register, which is always EXT_SENS_DATA_00 for I ² C slave 0. 0 – Function is disabled for this slave.
6	I2C_SLV0_BYTE_SW	1 – Swap bytes when reading both the low and high byte of a word. Note there is nothing to swap after reading the first byte if I2C_SLV0_REG[0] = 1, or if the last byte read has a register address lsb = 0. For example, if I2C_SLV0_REG = 0x1, and I2C_SLV0 LENG = 0x4: 1) The first byte read from address 0x1 will be stored at EXT_SENS_DATA_00, 2) the second and third bytes will be read and swapped, so the data read from address 0x2 will be stored at EXT_SENS_DATA_02, and the data read from address 0x3 will be stored at EXT_SENS_DATA_01, 3) The last byte read from address 0x4 will be stored at EXT_SENS_DATA_03. 0 – No swapping occurs; bytes are written in order read.
5	I2C_SLV0_REG_DIS	When set, the transaction does not write a register value, it will only read data, or write data.
4	I2C_SLV0_GRP	External sensor data typically comes in as groups of two bytes. This bit is used to determine if the groups are from the slave's register address 0 and 1, 2 and 3, etc., or if the groups are address 1 and 2, 3 and 4, etc. 0 indicates slave register addresses 0 and 1 are grouped together (odd numbered register ends the group). 1 indicates slave register addresses 1 and 2 are grouped together (even numbered register ends the group). This allows byte swapping of registers that are grouped starting at any address.
3:0	I2C_SLV0 LENG[3:0]	Number of bytes to be read from I ² C slave 0.

11.7 I2C_SLV0_DO

Name: I2C_SLV0_DO Address: 6 (06h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV0_DO[7:0]	Data out when slave 0 is set to write.

11.8 I2C_SLV1_ADDR

Name: I2C_SLV1_ADDR Address: 7 (07h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV1_RNW	1 – Transfer is a read. 0 – Transfer is a write.
6:0	I2C_ID_1[6:0]	Physical address of I ² C slave 1.

11.9 I2C_SLV1_REG

Name: I2C_SLV1_REG Address: 8 (08h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV1_REG[7:0]	I ² C slave 1 register address from where to begin data transfer.

11.10 I2C_SLV1_CTRL

Name: I2C_SLV1_CTRL Address: 9 (09h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV1_EN	1 – Enable reading data from this slave at the sample rate and storing data at the first available EXT_SENS_DATA register as determined by I2C_SLV0_EN and I2C_SLV0 LENG. 0 – Function is disabled for this slave.
6	I2C_SLV1_BYTE_SW	1 – Swap bytes when reading both the low and high byte of a word. Note there is nothing to swap after reading the first byte if I2C_SLV1_REG[0] = 1, or if the last byte read has a register address lsb = 0. For example, if I2C_SLV0_EN = 0x1, and I2C_SLV0 LENG = 0x3 (to show swap has to do with I2C slave address not EXT_SENS_DATA address), and if I2C_SLV1_REG = 0x1, and I2C_SLV1 LENG = 0x4: 1) The first byte read from address 0x1 will be stored at EXT_SENS_DATA_03 (slave 0's data will be in EXT_SENS_DATA_00, EXT_SENS_DATA_01, and EXT_SENS_DATA_02), 2) the second and third bytes will be read and swapped, so the data read from address 0x2 will be stored at EXT_SENS_DATA_04, and the data read from address 0x3 will be stored at EXT_SENS_DATA_05, 3) The last byte read from address 0x4 will be stored at EXT_SENS_DATA_06. 0 – No swapping occurs, bytes are written in order read.
5	I2C_SLV1_REG_DIS	When set, the transaction does not write a register value, it will only read data, or write data.
4	I2C_SLV1_GRP	External sensor data typically comes in as groups of two bytes. This bit is used to determine if the groups are from the slave's register address 0 and 1, 2 and 3, etc., or if the groups are address 1 and 2, 3 and 4, etc. 0 indicates slave register addresses 0 and 1 are grouped together (odd numbered register ends the group). 1 indicates slave register addresses 1 and 2 are grouped together (even numbered register ends the group). This allows byte swapping of registers that are grouped starting at any address.
3:0	I2C_SLV1_LENG[3:0]	Number of bytes to be read from I ² C slave 1.

11.11 I2C_SLV1_DO

Name: I2C_SLV1_DO Address: 10 (0Ah) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV1_DO[7:0]	Data out when slave 1 is set to write.

11.12 I2C_SLV2_ADDR

Name: I2C_SLV2_ADDR Address: 11 (0Bh) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV2_RNW	1 – Transfer is a read. 0 – Transfer is a write.
6:0	I2C_ID_2[6:0]	Physical address of I ² C slave 2.

11.13 I2C_SLV2_REG

Name: I2C_SLV2_REG Address: 12 (0Ch) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV2_REG[7:0]	I ² C slave 2 register address from where to begin data transfer.

11.14 I2C_SLV2_CTRL

Name: I2C_SLV2_CTRL Address: 13 (0Dh) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV2_EN	1 – Enable reading data from this slave at the sample rate and storing data at the first available EXT_SENS_DATA register as determined by I2C_SLV0_EN, I2C_SLV0 LENG, I2C_SLV1_EN and I2C_SLV1 LENG. 0 – Function is disabled for this slave.
6	I2C_SLV2_BYTE_SW	1 – Swap bytes when reading both the low and high byte of a word. Note there is nothing to swap after reading the first byte if I2C_SLV2_REG[0] = 1, or if the last byte read has a register address lsb = 0. See I2C_SLV1_CTRL for an example. 0 – No swapping occurs, bytes are written in order read.
5	I2C_SLV2_REG_DIS	When set, the transaction does not write a register value, it will only read data, or write data.
4	I2C_SLV2_GRP	External sensor data typically comes in as groups of two bytes. This bit is used to determine if the groups are from the slave's register address 0 and 1, 2 and 3, etc., or if the groups are address 1 and 2, 3 and 4, etc. 0 indicates slave register addresses 0 and 1 are grouped together (odd numbered register ends the group). 1 indicates slave register addresses 1 and 2 are grouped together (even numbered register ends the group). This allows byte swapping of registers that are grouped starting at any address.
3:0	I2C_SLV2_LENG[3:0]	Number of bytes to be read from I ² C slave 2.

11.15 I2C_SLV2_DO

Name: I2C_SLV2_DO Address: 14 (0Eh) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV2_DO[7:0]	Data out when slave 2 is set to write.

11.16 I2C_SLV3_ADDR

Name: I2C_SLV3_ADDR Address: 15 (0Fh) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV3_RNW	1 – Transfer is a read. 0 – Transfer is a write.
6:0	I2C_ID_3[6:0]	Physical address of I ² C slave 3.

11.17 I2C_SLV3_REG

Name: I2C_SLV3_REG Address: 16 (10h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV3_REG[7:0]	I ² C slave 3 register address from where to begin data transfer.

11.18 I2C_SLV3_CTRL

Name: I2C_SLV3_CTRL Address: 17 (11h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV3_EN	1 – Enable reading data from this slave at the sample rate and storing data at the first available EXT_SENS_DATA register as determined by I2C_SLV0_EN, I2C_SLV0 LENG, I2C_SLV1_EN, I2C_SLV1 LENG, I2C_SLV2_EN and I2C_SLV2 LENG. 0 – Function is disabled for this slave.
6	I2C_SLV3_BYTE_SW	1 – Swap bytes when reading both the low and high byte of a word. Note there is nothing to swap after reading the first byte if I2C_SLV3_REG[0] = 1, or if the last byte read has a register address lsb = 0. See I2C_SLV1_CTRL for an example. 0 – No swapping occurs, bytes are written in order read.
5	I2C_SLV3_REG_DIS	When set, the transaction does not write a register value, it will only read data, or write data.
4	I2C_SLV3_GRP	External sensor data typically comes in as groups of two bytes. This bit is used to determine if the groups are from the slave's register address 0 and 1, 2 and 3, etc., or if the groups are address 1 and 2, 3 and 4, etc. 0 indicates slave register addresses 0 and 1 are grouped together (odd numbered register ends the group). 1 indicates slave register addresses 1 and 2 are grouped together (even numbered register ends the group). This allows byte swapping of registers that are grouped starting at any address.
3:0	I2C_SLV3_LENG[3:0]	Number of bytes to be read from I ² C slave 3.

11.19 I2C_SLV3_DO

Name: I2C_SLV3_DO Address: 18 (12h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV3_DO[7:0]	Data out when slave 3 is set to write.

11.20 I2C_SLV4_ADDR

Name: I2C_SLV4_ADDR Address: 19 (13h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV4_RNW	1 – Transfer is a read. 0 – Transfer is a write.
6:0	I2C_ID_4[6:0]	Physical address of I ² C slave 4.

NOTE: The I²C Slave 4 interface can be used to perform only single byte read and write transactions.

11.21 I2C_SLV4_REG

Name: I2C_SLV4_REG Address: 20 (14h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV4_REG[7:0]	I ² C slave 4 register address from where to begin data transfer.

11.22 I2C_SLV4_CTRL

Name: I2C_SLV4_CTRL Address: 21 (15h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7	I2C_SLV4_EN	1 – Enable data transfer with this slave at the sample rate. If read command, store data in I2C_SLV4_DI register, if write command, write data stored in I2C_SLV4_DO register. Bit is cleared when a single transfer is complete. Be sure to write I2C_SLV4_DO first. 0 – Function is disabled for this slave.
6	I2C_SLV4_INT_EN	1 – Enables the completion of the I2C slave 4 data transfer to cause an interrupt. 0 – Completion of the I2C slave 4 data transfer will not cause an interrupt.
5	I2C_SLV4_REG_DIS	When set, the transaction does not write a register value, it will only read data, or write data.
4:0	I2C_SLV4_DLY[4:0]	When enabled via the I2C_MST_DELAY_CTRL, those slaves will only be enabled every $1/(1+I2C_SLV4_DLY)$ samples as determined by I2C_MST_ODR_CONFIG.

11.23 I2C_SLV4_DO

Name: I2C_SLV4_DO Address: 22 (16h) Type: USR3 Bank: 3 Serial IF: R/W Reset Value: 0x00		
BIT	NAME	FUNCTION
7:0	I2C_SLV4_DO[7:0]	Data out when slave 4 is set to write.

11.24 I2C_SLV4_DI

Name: I2C_SLV4_DI

Address: 23 (17h)

Type: USR3

Bank: 3

Serial IF: R

Reset Value: 0x00

BIT	NAME	FUNCTION
7:0	I2C_SLV4_DI[7:0]	Data read from I ² C Slave 4.

11.25 REG_BANK_SEL

Name: REG_BANK_SEL

Address: 127 (7Fh)

Type:

Bank: 3

Serial IF: R/W

Reset Value: 0x00

BIT	NAME	FUNCTION
7:6	-	Reserved.
5:4	USER_BANK[1:0]	Use the following values in this bit-field to select a USER BANK. 0: Select USER BANK 0. 1: Select USER BANK 1. 2: Select USER BANK 2. 3: Select USER BANK 3.
3:0	-	Reserved.

12 REGISTER MAP FOR MAGNETOMETER

The register map for the ICM-20948's Magnetometer (AK09916) section is listed below.

NAME	ADDRESS	READ/WRITE	DESCRIPTION	BIT WIDTH	EXPLANATION
WIA2	01H	READ	Device ID	8	
ST1	10H	READ	Status 1	8	Data status
HXL	11H	READ	Measurement data	8	X-axis data
HXH	12H			8	
HYL	13H			8	Y-axis data
HYH	14H			8	
HZL	15H			8	Z-axis data
HZH	16H			8	
ST2	18H	READ	Status 2	8	Data status
CNTL2	31H	READ/ WRITE	Control 2	8	Control Settings
CNTL3	32H	READ/ WRITE	Control 3	8	Control Settings
TS1	33H	READ/ WRITE	Test	8	DO NOT ACCESS
TS2	34H	READ/ WRITE	Test	8	DO NOT ACCESS

Table 20. Register Table for Magnetometer

Addresses 00h to 18h, 30h to 32h are compliant with automatic increment function of serial interface respectively. In other modes, read data is not correct. When the address is in 00h to 18h, the address is incremented 00h → 01h → 02h → 03h → 10h → 11h → ... → 18h, and the address goes back to 00h after 18h. When the address is in 30h to 32h, the address goes back to 30h after 32h.

12.1 REGISTER MAP DESCRIPTION

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ-ONLY REGISTER									
01H	WIA2	0	0	0	0	1	0	0	1
10H	ST1	0	0	0	0	0	0	DOR	DRDY
11H	HXL	HX7	HX6	HX5	HX4	HX3	HX2	HX1	HX0
12H	HXH	HX15	HX14	HX13	HX12	HX11	HX10	HX9	HX8
13H	HYL	HY7	HY6	HY5	HY4	HY3	HY2	HY1	HY0
14H	HYH	HY15	HY14	HY13	HY12	HY11	HY10	HY9	HY8
15H	HZL	HZ7	HZ6	HZ5	HZ4	HZ3	HZ2	HZ1	HZ0
16H	HZH	HZ15	HZ14	HZ13	HZ12	HZ11	HZ10	HZ9	HZ8
18H	ST2	0	RSV30	RSV29	RSV28	HOFL	0	0	0
WRITE/READ REGISTER									
31H	CNTL2	0	0	0	MODE4	MODE3	MODE2	MODE1	MODE0
32H	CNTL3	0	0	0	0	0	0	0	SRST
33H	TS1	-	-	-	-	-	-	-	-
34H	TS2	-	-	-	-	-	-	-	-

Table 21. Register Map for Magnetometer

When VDD is turned ON, POR function works and all registers of AK09916 are initialized.

TS1 and TS2 are test registers for shipment test. Do not access these registers.

13 DETAILED DESCRIPTIONS FOR MAGNETOMETER REGISTERS

This section details each register within the ICM-20948 Magnetometer section.

13.1 WIA: DEVICE ID

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ-ONLY REGISTER									
01H	WIA	0	0	0	0	1	0	0	1

Device ID of AK09916. It is described in one byte and fixed value.

09H: fixed

13.2 ST1: STATUS 1

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ-ONLY REGISTER									
10H	ST1	0	0	0	0	0	0	DOR	DRDY
	Reset	0	0	0	0	0	0	0	0

DRDY: Data Ready

“0”: Normal

“1”: Data is ready

DRDY bit turns to “1” when data is ready in Single measurement mode, Continuous measurement mode 1, 2, 3, 4 or Self-test mode. It returns to “0” when any one of ST2 register or measurement data register (HXL to TMPS) is read.

DOR: Data Overrun

“0”: Normal

“1”: Data overrun

DOR bit turns to “1” when data has been skipped in Continuous measurement mode 1, 2, 3, 4. It returns to “0” when any one of ST2 register or measurement data register (HXL to TMPS) is read.

13.3 HXL TO HZH: MEASUREMENT DATA

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ-ONLY REGISTER									
11H	HXL	HX7	HX6	HX5	HX4	HX3	HX2	HX1	HX0
12H	HXH	HX15	HX14	HX13	HX12	HX11	HX10	HX9	HX8
13H	HYL	HY7	HY6	HY5	HY4	HY3	HY2	HY1	HY0
14H	HYH	HY15	HY14	HY13	HY12	HY11	HY10	HY9	HY8
15H	HZL	HZ7	HZ6	HZ5	HZ4	HZ3	HZ2	HZ1	HZ0
16H	HZH	HZ15	HZ14	HZ13	HZ12	HZ11	HZ10	HZ9	HZ8
	Reset	0	0	0	0	0	0	0	0

Measurement data of magnetic sensor X-axis/Y-axis/Z-axis

HXL[7:0]: X-axis measurement data lower 8bit

HXH[15:8]: X-axis measurement data higher 8bit

HYL[7:0]: Y-axis measurement data lower 8bit

HYH[15:8]: Y-axis measurement data higher 8bit

HZL[7:0]: Z-axis measurement data lower 8bit

HZH[15:8]: Z-axis measurement data higher 8bit

Measurement data is stored in two's complement and Little Endian format. Measurement range of each axis is from -32752 to 32752 in 16-bit output.

MEASUREMENT DATA (EACH AXIS) [15:0]			MAGNETIC FLUX DENSITY [μ T]
TWO'S COMPLEMENT	HEX	DECIMAL	
0111 1111 1111 0000	7FF0	32752	4912(max.)
0000 0000 0000 0001	0001	1	0.15
0000 0000 0000 0000	0000	0	0
1111 1111 1111 1111	FFFF	-1	-0.15
1000 0000 0001 0000	8010	-32752	-4912(min.)

Table 22. Magnetometer Measurement Data Format

13.4 ST2: STATUS 2

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ-ONLY REGISTER									
18H	ST2	0	RSV30	RSV29	RSV28	HOFL	0	0	0
	Reset	0	0	0	0	0	0	0	0

ST2[6:4] bits: Reserved register for AKM.

HOFL: Magnetic sensor overflow

"0": Normal

"1": Magnetic sensor overflow occurred

In Single measurement mode, Continuous measurement mode 1, 2, 3, 4, and Self-test mode, magnetic sensor may overflow even though measurement data register is not saturated. In this case, measurement data is not correct and HOFL bit turns to "1". When measurement data register is updated, HOFL bit is updated.

ST2 register has a role as data reading end register, also. When any of measurement data register (HXL to TMPS) is read in Continuous measurement mode 1, 2, 3, 4, it means data reading start and taken as data reading until ST2 register is read. Therefore, when any of measurement data is read, be sure to read ST2 register at the end.

13.5 CNTL2: CONTROL 2

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ/WRITE REGISTER									
31H	CNTL2	0	0	0	MPDE4	MODE3	MODE2	MODE1	MODE0
	Reset	0	0	0	0	0	0	0	0

MODE[4:0] bits: Operation mode setting

"00000": Power-down mode

"00001": Single measurement mode

"00010": Continuous measurement mode 1

"00100": Continuous measurement mode 2

“00110”: Continuous measurement mode 3

“01000”: Continuous measurement mode 4

“10000”: Self-test mode

Other code settings are prohibited

When each mode is set, AK09916 transits to the set mode.

13.6 CNTL3: CONTROL 3

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ/WRITE REGISTER									
32H	CNTL3	0	0	0	0	0	0	0	SRST
Reset		0	0	0	0	0	0	0	0

SRST: Soft reset

"0": Normal

"1": Reset

When “1” is set, all registers are initialized. After reset, SRST bit turns to “0” automatically.

13.7 TS1, TS2: TEST 1, 2

ADDR	REGISTER NAME	D7	D6	D5	D4	D3	D2	D1	D0
READ/WRITE REGISTER									
33H	TS1	-	-	-	-	-	-	-	-
34H	TS2	-	-	-	-	-	-	-	-
Reset		0	0	0	0	0	0	0	0

TS1 and TS2 registers are test registers for shipment test. Do not use these registers.

14 USE NOTES

14.1 GYROSCOPE MODE TRANSITION

When gyroscope is transitioning from low-power to low-noise mode, several unsettled output samples will be observed at the gyroscope output due to filter switching and settling. The number of unsettled gyroscope output samples depends on the filter and ODR settings.

14.2 POWER MANAGEMENT 1 REGISTER SETTING

CLKSEL[2:0] has to be set to 001 to achieve the datasheet performance.

14.3 DMP MEMORY ACCESS

Reading/writing DMP memory and FIFO through I²C in a multithreaded environment can cause wrong data being read. To avoid the issue, one may use SPI instead of I²C, or use I²C with mutexes.

14.4 TIME BASE CORRECTION

The system clock frequency at room temperature in gyroscope mode and 6-Axis mode varies from part to part, and the clock rates specified in datasheet are the nominal values. The percentage of frequency deviation from the nominal values for each part is logged in register TIMEBASE_CORRECTION_PLL, and the range of the code is $\pm 10\%$ with each LSB representing a step of 0.079%. For example, if on one part TIMEBASE_CORRECTION_PLL = 0x0C = d'12, it means the clock frequency in gyroscope mode and 6-Axis mode is $\sim 0.94\%$ faster than the nominal value.

When operating in accelerometer-only mode, the system clock frequency at room temperature is the nominal frequency over parts, and it is independent of the value stored in TIMEBASE_CORRECTION_PLL register.

14.5 I²C MASTER CLOCK FREQUENCY

I²C master clock frequency can be set by register I2C_MST_CLK as shown in Table 23. Due to temperature variation and part to part variation of system clock frequency in different power modes, I2C_MST_CLK should be set such that in all conditions the clock frequency will not exceed what a slave device can support. To achieve a targeted clock frequency of 400 kHz, MAX, it is recommended to set I2C_MST_CLK = 7 (345.6 kHz / 46.67% duty cycle).

I2C_MST_CLK	NOMINAL CLK FREQUENCY [KHZ]	DUTY CYCLE
0	370.29	50.00%
1	-	-
2	370.29	50.00%
3	432.00	50.00%
4	370.29	42.86%
5	370.29	50.00%
6	345.60	40.00%
7	345.60	46.67%
8	304.94	47.06%
9	432.00	50.00%
10	432.00	41.67%
11	432.00	41.67%
12	471.27	45.45%
13	432.00	50.00%

I2C_MST_CLK	NOMINAL CLK FREQUENCY [KHZ]	DUTY CYCLE
14	345.60	46.67%
15	345.60	46.67%

Table 23. I²C Master Clock Frequency

14.6 CLOCKING

The internal system clock sources include: (1) an internal relaxation oscillator, and (2) a PLL with MEMS gyroscope oscillator as the reference clock. With the recommended clock selection setting (CLKSEL = 1), the best clock source for optimum sensor performance and power consumption will be automatically selected based on the power mode. Specifically, the internal relaxation oscillator will be selected when operating in accelerometer only mode, while the PLL will be selected whenever gyroscope is on, which includes gyroscope and 6-axis modes.

As clock accuracy is critical to the preciseness of distance and angle calculations performed by DMP, it should be noted that the internal relaxation oscillator and PLL show different performances in some aspects. The internal relaxation oscillator is trimmed to have a consistent operating frequency at room temperature, while the PLL clock frequency varies from part to part. The PLL frequency deviation from the nominal value in percentage is captured in register TIMEBASE_CORRECTION_PLL, and users can factor it in during distance and angle calculations to not sacrifice accuracy. Other than that, PLL has better frequency stability and lower frequency variation over temperature than the internal relaxation oscillator.

14.7 LP_EN BIT-FIELD USAGE

The LP_EN bit-field (User Bank 0, PWR_MGMT_1 register, bit [5] helps to reduce the digital current. The recommended setting for this bit-field is 1 to achieve the lowest possible current. However, when LP_EN is set to 1, user may not be able to write to the following registers. If it is desired to write to registers in this list, it is recommended to first set LP_EN=0, write the desired register(s), then set LP_EN=1 again:

- USER BANK 0: All registers except LP_CONFIG, PWR_MGMT_1, PWR_MGMT_2, INT_PIN_CFG, INT_ENABLE, FIFO_COUNTH, FIFO_COUNTL, FIFO_R_W, FIFO_CFG, REG_BANK_SEL
- USER BANK 1: All registers except REG_BANK_SEL
- USER BANK 2: All registers except REG_BANK_SEL
- USER BANK 3: All registers except REG_BANK_SEL

14.8 REGISTER ACCESS USING SPI INTERFACE

Using the SPI interface, when the AP/user disables the gyroscope sensor (User Bank 0, PWR_MGMT_2 register, bits [2:0]=111) as part of a sequence of register read or write commands, the AP/user will be required to subsequently wait 22 μ s prior to any of the following operations:

(1) Writing to any of the following registers:

- USER BANK 0: All registers except LP_CONFIG, PWR_MGMT_1, PWR_MGMT_2, INT_PIN_CFG, INT_ENABLE, FIFO_COUNTH, FIFO_COUNTL, FIFO_R_W, FIFO_CFG, REG_BANK_SEL
- USER BANK 1: All registers except REG_BANK_SEL
- USER BANK 2: All registers except REG_BANK_SEL
- USER BANK 3: All registers except REG_BANK_SEL

(2) Reading data from FIFO

(3) Reading from memory

15 ORIENTATION OF AXES

Figure 12 and Figure 13 show the orientation of the axes of sensitivity and the polarity of rotation. Note the pin 1 identifier (•) in the figures.

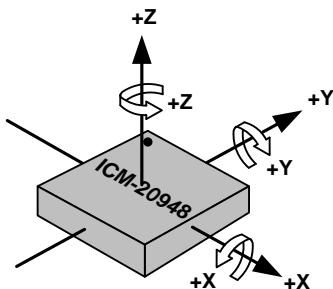


Figure 12. Orientation of Axes of Sensitivity and Polarity of Rotation

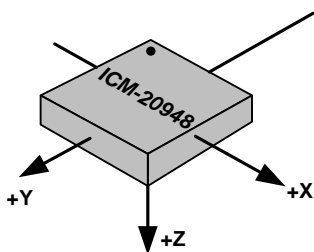


Figure 13. Orientation of Axes of Sensitivity for Magnetometer

16 PACKAGE DIMENSIONS

This section provides package dimensions for the device. Information for the 24 Lead QFN 3.0x3.0x0.9 package is in Figure 14 and Table 24

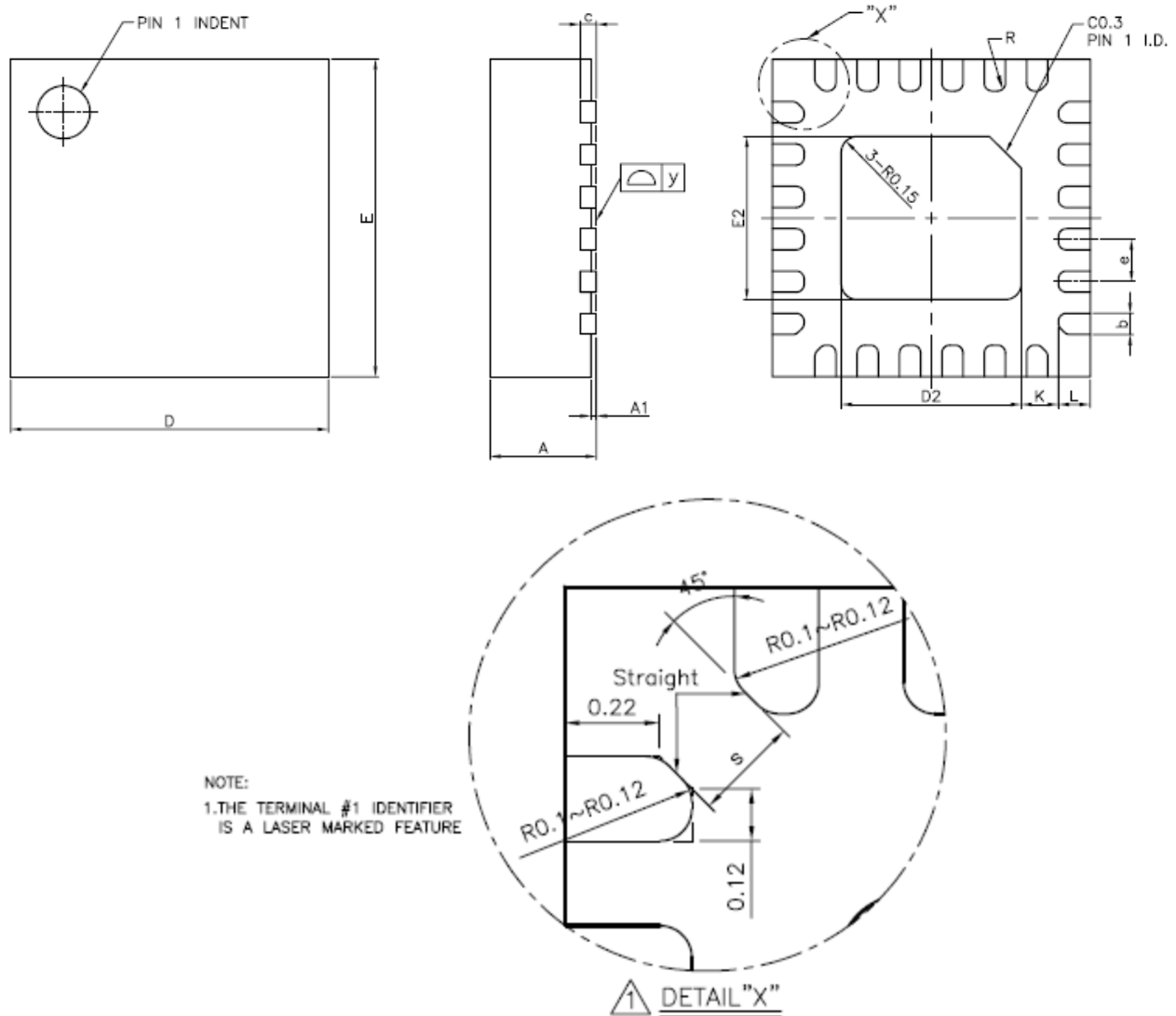


Figure 14. Package Dimensions

SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.95	1.00	1.05
A1	0.00	0.02	0.05
b	0.15	0.20	0.25
c	---	0.15 REF.	---
D	2.90	3.00	3.10
D2	1.65	1.70	1.75
E	2.90	3.00	3.10
E2	1.49	1.54	1.59
e	---	0.40	---
K	---	0.35 REF.	---
L	0.25	0.30	0.35
R	0.075	REF.	---
s	---	0.25 REF.	---
y	0.00	---	0.075

Table 24. Package Dimensions

17 PART NUMBER PART MARKINGS

The part number part markings for ICM-20948 devices are summarized below:

PART NUMBER	PART NUMBER PART MARKING
ICM-20948	I2948

Table 25. Part Number Part Markings

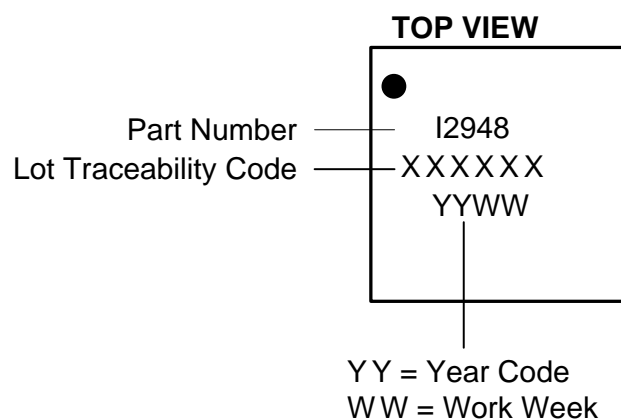


Figure 15. Part Number Part Markings

18 REFERENCES

Please refer to “InvenSense MEMS Handling Application Note (AN-IVS-0002A-00)” for the following information:

- Manufacturing Recommendations
 - Assembly Guidelines and Recommendations
 - PCB Design Guidelines and Recommendations
 - MEMS Handling Instructions
 - ESD Considerations
 - Reflow Specification
 - Storage Specifications
 - Package Marking Specification
 - Tape & Reel Specification
 - Reel & Pizza Box Label
 - Packaging
 - Representative Shipping Carton Label
- Compliance
 - Environmental Compliance
 - DRC Compliance
 - Compliance Declaration Disclaimer

19 DOCUMENT INFORMATION

19.1 REVISION HISTORY

REVISION DATE	REVISION	DESCRIPTION
12/07/2016	1.0	Initial Release
1/17/2017	1.1	Formatting fix
04/06/2017	1.2	Updated Section 4
06/02/2017	1.3	Updated Sections 3, 4